

OCTAL T1/E1 SHORT HAUL ANALOG FRONT END

IDT82V2048L

FEATURES

- ullet Octal T1/E1 short haul analog front end which supports 100 Ω T1 twisted pair, 120 Ω E1 twisted pair and 75 Ω E1 coaxial applications
- ◆ Built-in transmit pre-equalization meets G.703 & T1.102
- ◆ Digital/Analog LOS detector meets ITU G.775, ETS 300 233 and T1.231
- ◆ ITU G.772 non-intrusive monitoring for in-service testing for any one of channel 1 to channel 7
- Low impedance transmit drivers with high-Z
- Selectable hardware and parallel/serial host interface

- Hitless Protection Switching (HPS) for 1 to 1 protection without
- JTAG boundary scan for board test
- 3.3 V supply with 5 V tolerant I/O
- Low power consumption
- Operating temperature range: -40°C to +85°C
- ◆ Available in 144-pin Thin Quad Flat Pack (TQFP) and 160-pin Plastic Ball Grid Array (PBGA) packages Green package options available

FUNCTIONAL BLOCK DIAGRAM

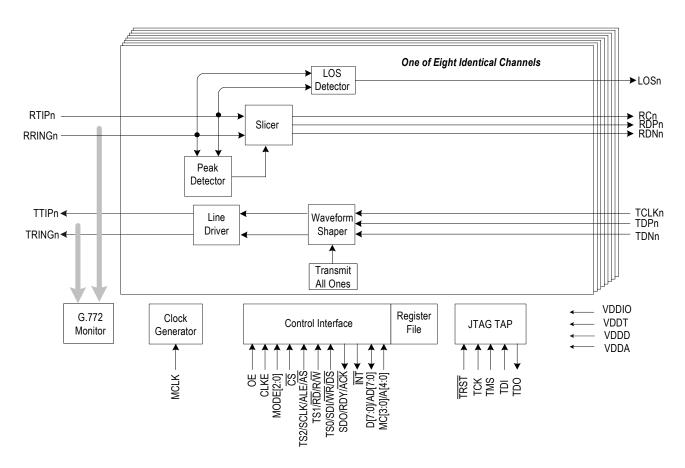


Figure-1 Block Diagram

July, 2005 IDT and the IDT logo are trademarks of Integrated Device Technology, Inc.

DSC-6527/1 © 2005 Integrated Device Technology, Inc.

PIN CONFIGURATIONS

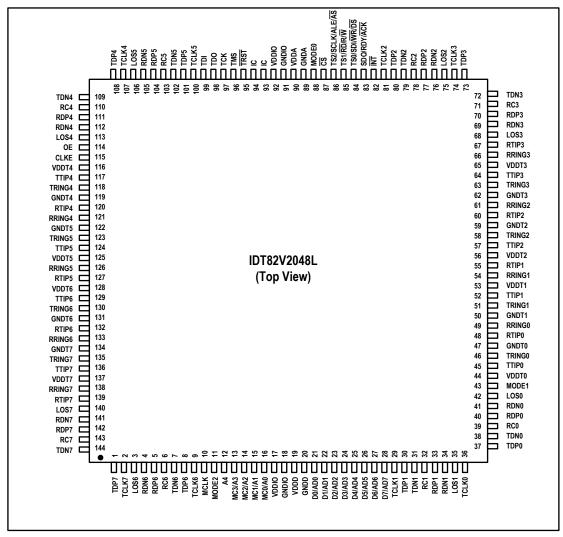


Figure-2 TQFP144 Package Pin Assignment

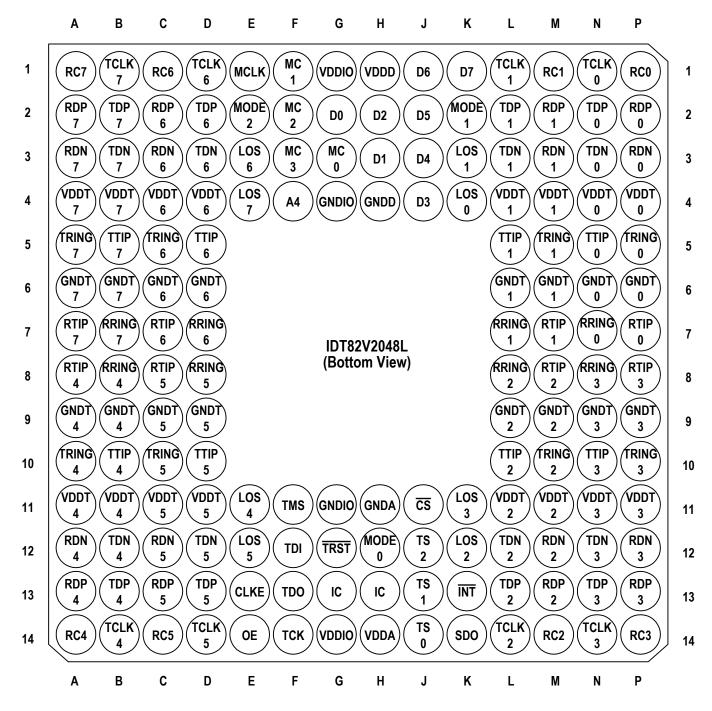


Figure-3 PBGA160 Package Pin Assignment

1 PIN DESCRIPTION

Table-1 Pin Description

| Name | Tuno | Pin | No. | Description |
|--------|--------|-------------------|------------|---|
| Name | Туре | TQFP144 | PBGA160 | Description |
| | I | | | Transmit and Receive Line Interface |
| TTIP0 | | 45 | N5 | |
| TTIP1 | | 52 | L5 | |
| TTIP2 | | 57 L10 64 N10 | | |
| TTIP3 | | | N10 | |
| TTIP4 | | 117 | B10 | |
| TTIP5 | | 124 | D10 | |
| TTIP6 | | 129 | D5 | TTIPn/TRINGn: Transmit Bipolar Tip/Ring for Channel 0~7 |
| TTIP7 | A 1 | 136 | B5 | These pins are the differential line driver outputs. They will be in high impedance state if pin OE is low or |
| | Analog | | | the corresponding pin TCLKn is low (pin OE is global control, while pin TCLKn is per-channel control). In |
| TRING0 | Output | 46 | P5 | host mode, each pin can be in high impedance by programming a '1' to the corresponding bit in register |
| TRING1 | | 51 M5 | M5 | OE ⁽¹⁾ . |
| TRING2 | | 58 | M10 | |
| TRING3 | | 63 P10 118 A10 | P10 | |
| TRING4 | | | A10 | |
| TRING5 | | 123 130 | | |
| TRING6 | | | | |
| TRING7 | | 135 | A5 | |
| RTIP0 | | 48 | P7 | |
| RTIP1 | | 55 | M7 | |
| RTIP2 | | 60 | M8 | |
| RTIP3 | | 67 | P8 | |
| RTIP4 | | 120 | A8 | |
| RTIP5 | | 127 | C8 | |
| RTIP6 | | 132 | C 7 | |
| RTIP7 | A 1 | 139 | A7 | DTID:/DDINO:- Deceive Discles Tis/Discretes Observed 0.7 |
| | Analog | | | RTIPn/RRINGn: Receive Bipolar Tip/Ring for Channel 0~7 |
| RRING0 | Input | 49 | N7 | These pins are the differential line receiver inputs. |
| RRING1 | | 54 | L7 | |
| RRING2 | | 61 | L8 | |
| RRING3 | | 66 | N8 | |
| RRING4 | | 121 | B8 | |
| RRING5 | | 126 | D8 | |
| RRING6 | | 133 | D7 | |
| RRING7 | | 138 | B7 | |

¹. Register name is indicated by bold capital letter. For example, **OE** indicates Output Enable Register.

Table-1 Pin Description (Continued)

| | - | Pin | No. | | | | |
|-------|--------|---------|---------|--|--|--|--|
| Name | Туре | TQFP144 | PBGA160 | Description | | | |
| | | | | Transmit and Receive Digital Data Interface | | | |
| TDP0 | | 37 | N2 | | | | |
| TDP1 | | 30 | L2 | | | | |
| TDP2 | | 80 | L13 | | | | |
| TDP3 | | 73 | N13 | | | | |
| TDP4 | | 108 | B13 | TDPn/TDNn: Positive/Negative Transmit Data for Channel 0~7 | | | |
| TDP5 | | 101 | D13 | The NRZ data to be transmitted for positive/negative pulse is input on this pin. Data on TDPn/TDNn are | | | |
| TDP6 | | 8 | D2 | active high and are sampled on the falling edges of TCLKn. | | | |
| TDP7 | | 1 | B2 | | | | |
| | 1 | | | | | | |
| TDN0 | | 38 | N3 | 0 Space | | | |
| TDN1 | | 31 | L3 | 0 1 Negative Pulse | | | |
| TDN2 | | 79 | L12 | 1 0 Positive Pulse 1 1 Space | | | |
| TDN3 | | 72 | N12 | 11 | | | |
| TDN4 | | 109 | B12 | | | | |
| TDN5 | | 102 | D12 | | | | |
| TDN6 | | 7 | D3 | | | | |
| TDN7 | | 144 | В3 | | | | |
| TCLK0 | | 36 | N1 | | | | |
| TCLK1 | | 29 | L1 | TOLK T VOL. 16 D 10 T. | | | |
| TCLK2 | | 81 | L14 | TCLKn: Transmit Clock for Channel 0~7 | | | |
| TCLK3 | | 74 | N14 | The clock of 1.544 MHz (for T1 mode) or 2.048 MHz (for E1 mode) for transmit is input on this pin. The | | | |
| TCLK4 | I | 107 | B14 | transmit data at TDPn or TDNn is sampled into the device on the falling edges of TCLKn. | | | |
| TCLK5 | | 100 | D14 | Different combinations of TCLKn and MCLK result in different transmit mode. It is summarized as Table-2 | | | |
| TCLK6 | | 9 | D1 | System Interface Configuration. | | | |
| TCLK7 | | 2 | B1 | | | | |
| RDP0 | | 40 | P2 | | | | |
| RDP1 | | 33 | M2 | | | | |
| RDP2 | | 77 | M13 | | | | |
| RDP3 | | 70 | P13 | | | | |
| RDP4 | | 111 | A13 | | | | |
| RDP5 | | 104 | C13 | | | | |
| RDP6 | 0 | 5 | C2 | RDPn/RDNn: Positive/Negative Receive Data for Channel 0~7 | | | |
| RDP7 | - | 142 | A2 | These pins output the raw RZ sliced data. The active polarity of RDPn/RDNn is determined by pin CLKE. | | | |
| | High | | | When pin CLKE is low, RDPn/RDNn is active low. When pin CLKE is high, RPDn/RDNn is active high. | | | |
| RDN0 | Imped- | 41 | P3 | RDPn/RDNn will remain active during LOS. RDPn/RDNn is set into high impedance when the correspond- | | | |
| RDN1 | ance | 34 | M3 | ing receiver is powered down. | | | |
| RDN2 | - | 76 | M12 | | | | |
| RDN3 | | 69 | P12 | | | | |
| RDN4 | | 112 | A12 | | | | |
| RDN5 | | 105 | C12 | | | | |
| RDN6 | | 4 | C3 | | | | |
| RDN7 | | 141 | A3 | | | | |
| RC0 | | 39 | P1 | | | | |
| RC1 | | 32 | M1 | | | | |
| RC2 | 0 | 78 | M14 | RCn: Receive Pulse for Channel 0~7 | | | |
| RC3 | | 71 | P14 | RCn: Receive Pulse for Channel 0~7 RCn is the output of an internal exclusive OR (XOR) which is connected with RDPn and RDNn. The clock | | | |
| RC4 | High | 110 | A14 | is recovered from the signal on RCn. If receiver n is powered down, the corresponding RCn will be in high | | | |
| RC5 | Imped- | 103 | C14 | impedance. | | | |
| RC6 | ance | 6 | C14 | impodunos. | | | |
| RC7 | | 143 | A1 | | | | |
| IXO1 | | 143 | - AI | | | | |

Table-1 Pin Description (Continued)

| Name Type Description | | Description | | | | | | |
|--|-----------------------------|--|--|---|--|-------------|--|--|
| Name | Туре | TQFP144 | PBGA160 | | | Description | | |
| MCLK | ı | 10 | E1 | MCLK: Master Clock This is an independent, free running reference clock. A clock of 1.544 MHz (for T1 mode) or 2.048 MHz (for E1 mode) is supplied to this pin as the clock reference of the device for normal operation. When MCLK is low, all the receivers are powered down, and the output pins RCn, RDPn and RDNn are switched to high impedance. In transmit path, the operation mode is decided by the combination of MCLK and TCLKn (See Table-2 System Interface Configuration for details). NOTE: Wait state generation via RDY/ACK is not available if MCLK is not provided. | | | | |
| LOS0 LOS1 LOS2 LOS3 LOS4 LOS5 LOS6 LOS7 | 0 | 42 35 75 68 113 106 3 140 | K4 K3 K12 K11 E11 E12 E3 E4 | LOSn: Loss of Signal Output for Channel 0~7 A high level on this pin indicates the loss of signal when there is no transition over a specified period of time or no enough ones density in the received signal. The transition will return to low automatically when there is enough transitions over a specified period of time with a certain ones density in the received signal. The LOS assertion and desertion criteria are described in 2.4.3 Loss of Signal (LOS) Detection. | | | | |
| Hardware/Host Control Interface | | | | | | | | |
| MODE2 | l (Pulled to VDDIO/2) | 11 | E2 | MODE2: Control Mode Select 2 ⁽²⁾ The signal on this pin determines which control mode is selected to control the device: MODE2 | | | | |
| MODE1 | ı | 43 | K2 | MODE1: Control Mode Select 1 ⁽²⁾ In parallel host mode, the parallel interface operates with separate address bus and data bus when this pin is low, and operates with multiplexed address and data bus when this pin is high. In serial host mode or hardware mode, this pin should be grounded. | | | | |
| MODE0 | I | 88 | H12 | MODE0: Control Mode Select 0 ⁽²⁾ In parallel host mode, the parallel host interface is configured for Motorola compatible hosts when this pin is low, or for Intel compatible hosts when this pin is high. In serial host mode or hardware mode, this pin should be grounded. | | | | |
| cs | (Pulled to VDDIO/2) | 87 | J11 | CS: Chip Select (Active Low) In host mode, this pin is asserted low by the host to enable host interface. A high to low transition must occur on this pin for each read/write operation and the level must not return to high until the operation is over. In hardware control mode, this pin should be pulled to VDDIO/2. | | | | |

². In host mode, register **e-AFE** has to be set to 'FFH' for proper device operation. See Expanded Register Description on page 28 for more details.

Table-1 Pin Description (Continued)

| Nama | Tuna | Pin | No. | Description | |
|---|-----------------|--|-------------|---|--|
| Name | TQFP144 PBGA160 | | Description | | |
| TS2/SCLK/ ALE/ĀS I 86 | | 86 J12 | | TS2: Template Select 2 In hardware control mode, the signal on this pin is the most significant bit for the transmit template select. Refer to 2.5.1 Waveform Shaper for details. SCLK: Shift Clock In serial host mode, the signal on this pin is the shift clock for the serial interface. Data on pin SDO is clocked out on falling edges of SCLK if pin CLKE is high, or on rising edges of SCLK if pin CLKE is low. Data on pin SDI is always sampled on rising edges of SCLK. ALE: Address Latch Enable In parallel Intel multiplexed host mode, the address on AD[4:0] is sampled into the device on the falling edges of ALE (signals on AD[7:5] are ignored). In non-multiplexed host mode, ALE should be pulled high. AS: Address Strobe (Active Low) In parallel Motorola multiplexed host mode, the address on AD[4:0] is latched into the device on the falling | |
| | | | | edges of \overline{AS} (signals on AD[7:5] are ignored). In non-multiplexed host mode, \overline{AS} should be pulled high. TS1: Template Select 1 In hardware control mode, the signal on this pin is the second most significant bit for the transmit template | |
| TS1/RD/R/W I | | 85 | J13 | select. Refer to 2.5.1 Waveform Shaper for details. \overline{\overline{RD}: Read Strobe (Active Low)} In parallel Intel multiplexed or non-multiplexed host mode, this pin is active low for read operation. \overline{R\overline{W}: Read/Write Select} In parallel Motorola multiplexed or non-multiplexed host mode, the pin is active low for write operation and high for read operation. | |
| In parallel Motorola multiplexed or non-multiple high for read operation. TS0: Template Select 0 In hardware control mode, the signal on this parallel material host mode, the signal on this parallel host mode, this pin input the data to the edges of SCLK. TS0/SDI/WR/ DS I 84 J14 WR: Write Strobe (Active Low) In parallel Intel host mode, this pin is active log plexed mode) or AD[7:0] (in multiplexed mode) DS: Data Strobe (Active Low) In parallel Motorola host mode, this pin is active (in non-multiplexed mode) or AD[7:0] (in multiplexed mode) or AD[7:0] (in multiplexed mode) by the device on the rise in parallel Motorola non-multiplexed host mode) | | TS0: Template Select 0 In hardware control mode, the signal on this pin is the least significant bit for the transmit template select. Refer to 2.5.1 Waveform Shaper for details. SDI: Serial Data Input In serial host mode, this pin input the data to the serial interface. Data on this pin is sampled on the rising edges of SCLK. WR: Write Strobe (Active Low) In parallel Intel host mode, this pin is active low during write operation. The data on D[7:0] (in non-multiplexed mode) or AD[7:0] (in multiplexed mode) is sampled into the device on the rising edges of WR. | | | |

Table-1 Pin Description (Continued)

| Name | Type | Pin No. | | Description | |
|--|--------------------|----------------------------|----------------------------|---|--|
| Name | туре | TQFP144 | PBGA160 | Description | |
| | | | | SDO: Serial Data Output In serial host mode, the data is output on this pin. In serial write operation, SDO is always in high impedance. In serial read operation, SDO is in high impedance only when SDI is in address/command byte. Data on pin SDO is clocked out of the device on the falling edges of SCLK if pin CLKE is high, or on the rising edges of SCLK if pin CLKE is low. | |
| SDO/RDY/ACK | 0 | 83 | K14 | RDY: Ready Output In parallel Intel host mode, the high level of this pin reports to the host that bus cycle can be completed, while low reports the host must insert wait states. | |
| | | | | ACK: Acknowledge Output (Active Low) In parallel Motorola host mode, the low level of this pin indicates that valid information on the data bus is ready for a read operation or acknowledges the acceptance of the written data during a write operation. | |
| ĪNT | O Open Drain | 82 | K13 | INT: Interrupt (Active Low) This is an open drain, active low interrupt output. Two sources may cause the interrupt. Refer to 2.19 Interrupt Handling for details. | |
| D7/AD7 D6/AD6 D5/AD5 D4/AD4 D3/AD3 | I/O High | 28 27 26 25 24 | K1 J1 J2 J3 J4 | Dn: Data Bus 7~0 In non-multiplexed host mode, these pins are the bi-directional data bus. ADn: Address/Data Bus 7~0 In multiplexed host mode, these pins are the multiplexed by directional address/data bus. | |
| D2/AD2 D1/AD1 D0/AD0 | Imped- ance | 23 22 21 | H2 H3 G2 | In multiplexed host mode, these pins are the multiplexed bi-directional address/data bus. In hardware mode, these pins should be tied to VDDIO/2. In serial host mode, these pins should be grounded. | |

Table-1 Pin Description (Continued)

| N | T | Pin | No. | Decembrion | | |
|--|--------------|----------------------------|----------------------------|--|--|--|
| Name | Туре | TQFP144 | PBGA160 | Description | | |
| A4 MC3/A3 MC2/A2 MC1/A1 MC0/A0 | I | 12 13 14 15 16 | F4 F3 F2 F1 G3 | In hardware control mode, A4 must be connected to GND. MC[3:0] are used to select a transmitter or receiver of channel 1 to 7 for non-intrusive monitoring. Channel 0 is used as the monitoring channel. If transmitter is monitored, signals on the corresponding pins TTIPn and TRINGn are internally transmitte to RTIP0 and RRING0 pins. If a receiver is monitored, signals on the corresponding pins RTIPn and RRINGn are internally transmitted to RTIP0 and RRING0 pins. The monitored is then output to RDP0 a RDN0 pins. Performance Monitor Configuration determined by MC[3:0] is shown below. Note that if MC[2:0] = 000, device is in normal operation of all the channels. MC[3:0] Monitoring Configuration | | |
| OE | I | 114 | E14 | OE: Output Driver Enable Pulling this pin low can drive all driver output into high impedance for redundancy application without external mechanical relays. In this condition, all other internal circuits remain active. | | |
| CLKE | I | 115 | E13 | CLKE: Clock Edge Select The signal on this pin determines the active edge of RCn, RDPn, RDNn and SCLK. Refer to 2.3 Clock Edges for details. | | |
| | | | | JTAG Signals | | |
| TRST | I Pull-up | 95 | G12 | TRST: JTAG Test Port Reset (Active Low) This is the active low asynchronous reset to the JTAG Test Port. This pin has an internal pull-up resistor and can be left disconnected. | | |
| TMS | I Pull-up | 96 | F11 | TMS: JTAG Test Mode Select The signal on this pin controls the JTAG test performance and is clocked into the device on the rising edges of TCK. This pin has an internal pull-up resistor and can be left disconnected. | | |
| тск | I | 97 | F14 | TCK: JTAG Test Clock The clock of the JTAG test is input on this pin. The data on TDI and TMS are clocked into the device on rising edges of TCK while the data on TDO pin is clocked out of the device on falling edges of TCK. This pin should be connected to GNDIO or VDDIO pin when unused. | | |

Table-1 Pin Description (Continued)

| Nama | T | Pin | No. | Description | |
|--|-----------------------------|--|--|--|--|
| Name | Туре | TQFP144 | PBGA160 | Description | |
| TDO | O High Imped- ance | 98 | F13 | TDO: JTAG Test Data Output The serial data of the JTAG test is output on this pin. The data on TDO pin is clocked out of the device on the falling edges of TCK. TDO is a high impedance output signal. It is active only when scanning of data is over. This pin should be left float when unused. | |
| TDI | l Pull-up | 99 | F12 | TDI: JTAG Test Data Input The serial data of the JTAG test is input on this pin. The data on TDI pin is clocked into the device on the rising edges of TCK. This pin has an internal pull-up resistor and it can be left disconnected. | |
| | 1 | | I | Power Supplies and Grounds | |
| VDDIO | - | 17 92 | G1 G14 | 3.3 V I/O Power Supply | |
| GNDIO | - | 18 91 | G4 G11 | I/O GND | |
| VDDT0 VDDT1 VDDT2 VDDT3 VDDT4 VDDT5 VDDT6 VDDT7 | | 44 53 56 65 116 125 128 137 | N4, P4 L4, M4 L11, M11 N11, P11 A11, B11 C11, D11 C4, D4 A4, B4 | 3.3 V/5 V Power Supply for Transmitter Driver All VDDT pins must be connected to 3.3 V or all VDDT must be connected to 5 V. It is not allowed to leave any of the VDDT pins open (not-connected) even if the channel is not used. T1 is only 5V VDDT. | |
| GNDT0 GNDT1 GNDT2 GNDT3 GNDT4 GNDT5 GNDT6 GNDT7 | - | 47 50 59 62 119 122 131 134 | N6, P6 L6, M6 L9, M9 N9, P9 A9, B9 C9, D9 C6, D6 A6, B6 | Analog GND for Transmitter Driver | |
| VDDD VDDA | - | 19 90 | H1 H14 | 3.3 V Digital/Analog Core Power Supply | |
| GNDD GNDA | - | 20 89 | H4 H11 | Digital/Analog Core GND | |
| | ı | | ı | Others | |
| IC | - | 93 | G13 | IC: Internal Connection Internal use. Leave it open for normal operation. | |
| IC | - | 94 | H13 | IC: Internal Connection Internal use. Leave it open for normal operation. | |

2 FUNCTIONAL DESCRIPTION

2.1 OVERVIEW

The IDT82V2048L is a fully integrated octal short-haul analog front end (AFE), which contains eight transmit and receive channels for use in either T1 or E1 applications. The raw sliced data (no retiming) is output to the system. Transmit equalization is implemented with low-impedance output drivers that provide shaped waveforms to the transformer, guaranteeing template conformance. Moreover, testing functions, such as JTAG boundary scan is provided. The device is optimized for flexible software control through a serial or parallel host mode interface. Hardware control is also available. Figure-1 on page 1 shows one of the eight identical channels operation.

2.2 T1/E1 MODE SELECTION

T1/E1 mode selection configures the device globally. In Hardware control Mode, the template selection pins TS[2:0], determine whether the operation mode is T1 or E1 (see Table-5 on page 14). In Software Mode, the register **TS** determines whether the operation mode is T1 or E1.

2.2.1 SYSTEM INTERFACE

The system interface of each channel operates in Dual Rail Mode with data recovery, that is, with raw data slicing only and without clock recovery.

The Dual Rail interface consist of TDPn¹, TDNn, TCLKn, RDPn, RDNn and RCn. Data transmitted from TDPn and TDNn appears on TTIPn and TRINGn at the line interface. The interface of the AFE is shown in Figure-4. Pin RDPn and RDNn, are raw RZ slice outputs and internally connected to an XOR which is fed to the RCn output for external clock recovery applications.

2.2.1.1 SYSTEM INTERFACE CONFIGURATION

For normal transmit and receive operation, the device is configured as follows:

In host mode, MCLK can be either clocked or pulled high. If MCLK is pulled high, TCLK1 has to be provided for proper device operation. In addition, register **e-AFE**² has to be set to 'FFH' to ensure proper device operation. See Expanded Register Description on page 28 for details.

In hardware mode, MCLK has to be pulled high and TCLK1 has to be provided for proper device operation.

Depending on the state of TCLK1 and TCLKn, the transmitter will Transmit All Ones (TAOS), will go into power down, or will go into high impedance.

The status of TCLK1 and TCLKn has no effect on the receive paths. By setting MCLK low, all the receive paths are powered down.

Table-2 summarizes the different combinations between MCLK and TCLKn.

¹ The footprint 'n' (n = 0 - 7) indicates one of the eight channels.

² The first letter 'e-' indicates expanded register.

Table-2 System Interface Configuration

| Host or Hardware Mode | MCLK | TCLK1 | TCLKn | AFEn in e-AFE | Transmitter Mode | | | | | |
|---------------------------------|---------------------------------------|---|----------------------------|-------------------|--|--|--|--|--|--|
| | Transmit and Receive Normal Operation | | | | | | | | | |
| Host ⁽¹⁾ only | Clocked | Clocked | Clocked | 1 | Normal operation | | | | | |
| Host or Hardware ⁽²⁾ | High | Clocked | Clocked | DC ⁽³⁾ | Normal operation | | | | | |
| | | | Transmit Inte | erface Modes | | | | | | |
| Host only | Clocked | High (≥ 16 MCLK) | | 1 | Transmit All Ones (TAOS) signals to the line side in the corresponding transmit channel. | | | | | |
| | | Low (≥ 64 M | CLK) | | Corresponding transmit channel is set into power down state. | | | | | |
| | High/Low | TCI K1 is clocked | TCLKn is high (≥ 16 TCLK1) | DC | Transmit All Ones (TAOS) signals to the line side in the corresponding transmit channel. | | | | | |
| Host or Hardware | | TOLIN IS GIOGRA | TCLKn is low (≥ 64 TCLK1) | | Corresponding transmit channel is set into power down state. | | | | | |
| | | TCLK1 is unavailable. | | | All eight transmitters (TTIPn & TRINGn) are in high impedance. | | | | | |
| | Receive Interface Modes | | | | | | | | | |
| Host or Hardware | Low | The receive path is not affected by the status of TCLK1 or TCLKn. | | DC | All the receive paths are powered down. | | | | | |

^{1.} In host mode, register **e-AFE** must be set to 'FFH' for proper operation. See Expanded Register Description on page 28 for details.

^{3.} DC means Don't Care

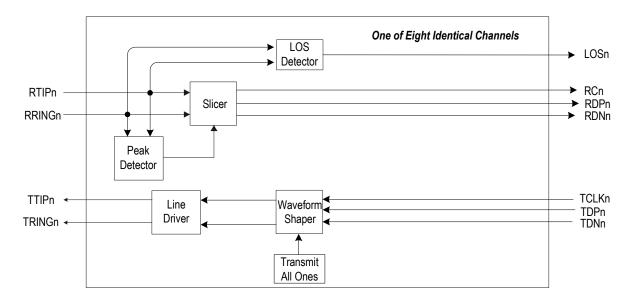


Figure-4 Analog Front End (AFE) Interface

^{2.} In hardware mode, MCLK must be pulled high and TCLK1 provided for proper operation.

2.3 CLOCK EDGES

The active edge of SCLK is selectable. If pin CLKE is high, the active edge of SCLK is the falling edge. On the contrary, if CLKE is low, the active edge SCLK is the rising edge. Pin SDO is always active high, and the output signals are valid on the active edge of SCLK. See Table-3 Active Clock Edge and Active Level for details. Pin CLKE is used to set the active level for RDPn/RDNn raw slicing output: high for active high polarity and low for active low. It should be noted that data on pin SDI are always active high and are sampled on the rising edges of SCLK. The data on pin TDPn or TDNn are also always active high but are sampled on the falling edges of TCLKn, despite the level on CLKE.

Table-3 Active Clock Edge and Active Level

| Pin CLKE | Pin RDPn and RDNn Slicer Output | Pin SDO | | |
|----------|------------------------------------|---------|-------------|--|
| High | Active High | SCLK | Active High | |
| Low | Active Low | SCLK | Active High | |

2.4 RECEIVER

In receive path, the line signals couple into RRINGn and RTIPn via a transformer and are converted into RZ digital pulses by a data slicer. Adaptation for attenuation is achieved using an integral peak detector that sets the slicing levels. The recovered data on pin RDPn/RDNn in an undecoded dual rail RZ format. Loss of signal is detected. This change in status may be enabled to generate an interrupt.

2.4.1 PEAK DETECTOR AND SLICER

The slicer determines the presence and polarity of the received pulses. The raw positive slicer output appears on RDPn while the negative slicer output appears on RDNn. The slicer circuit has a built-in peak detector from which the slicing threshold is derived. The slicing threshold is default to 50% (typical) of the peak value.

Signals with an attenuation of up to 12 dB (from 2.4 V) can be recovered by the receiver. To provide immunity from impulsive noise, the peak detectors are held above a minimum level of 0.150 V typically, despite the received signal level.

2.4.2 DATA RECOVERY

The analog line signal are converted to RZ digital bit streams on the RDPn/RDNn pins and internally connected to an XOR which is fed to the RCn output for external clock recovery applications.

2.4.3 LOSS OF SIGNAL (LOS) DETECTION

The Loss of Signal Detector monitors the amplitude and density of the received signal on receiver line before the transformer (measured on port A, B shown in Figure-7). The loss condition is reported by pulling pin LOSn high. At the same time, LOS alarm registers track LOS condition. When LOS is detected or cleared, an interrupt will generate if not masked. In host mode, the detection supports the ANSI T1.231 for T1 mode, ITU G.775 and ETSI 300 233 for E1 mode. In hardware mode, it supports the ITU G.775 and ANSI T1.231.

Table-4 summarizes the conditions of LOS. During LOS, the RDPn/RDNn continue to output the sliced data.

Table-4 LOS Condition

| | | | Standard | | Signal on |
|----------------|--------------------------|--|--|--|-----------|
| | | ANSI T1.231 for T1 | G.775 for E1 | ETSI 300 233 for E1 | LOSn |
| LOS | Continuous Intervals | 175 | 32 | 2048 (1 ms) | High |
| Detected | Amplitude ⁽¹⁾ | below typical 200 mVp | below typical 200 mVp | below typical 200 mVp | 111911 |
| LOS Cleared | Density | 12.5% (16 marks in a sliding 128-bit period) with no more than 99 continuous zeros | 12.5% (4 marks in a sliding 32-bit period) with no more than 15 continuous zeros | 12.5% (4 marks in a sliding 32-bit period) with no more than 15 continuous zeros | Low |
| | Amplitude ⁽¹⁾ | exceed typical 250 mVp | exceed typical 250 mVp | exceed typical 250 mVp | |

^{1.} LOS levels at device (RTIPn, RRINGn) with all ones signal. For more detail regarding the LOS parameters, please refer to Receiver Characteristics on page 38.

2.5 TRANSMITTER

In transmit path, data in NRZ format is clocked into the device on TDPn and TDNn. The data is sampled into the device on falling edges of TCLKn. The shape of the pulses are user programmable to ensure that the T1/E1 pulse template is met after the signal passes through different cable lengths or types.

2.5.1 WAVEFORM SHAPER

T1 pulse template, specified in the DSX-1 Cross-Connect by ANSI T1.102, is illustrated in Figure-5. The device has built-in transmit waveform templates, corresponding to 5 levels of pre-equalization for cable of a length from 0 to 655 ft with each increment of 133 ft.

E1 pulse template, specified in ITU-T G.703, is shown in Figure-6. The device has built-in transmit waveform templates for cable of 75 Ω or 120 Ω .

Any one of the six built-in waveforms can be chosen in both hardware mode and host mode. In hardware control mode, setting pins TS[2:0] can select the required waveform template for all the transmitters, as shown in Table-5. In host mode, the waveform template can be configured on a per-channel basis. Bits TSIA[2:0] in register **TSIA** are used to select the channel and bits TS[2:0] in register **TS** are used to select the required waveform template.

The built-in waveform shaper uses an internal high frequency clock which is 16XMCLK as the clock reference. This function will be bypassed when MCLK is unavailable.

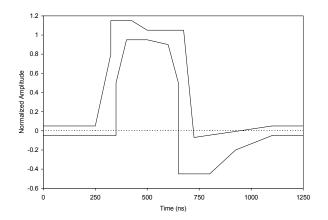


Figure-5 DSX-1 Waveform Template

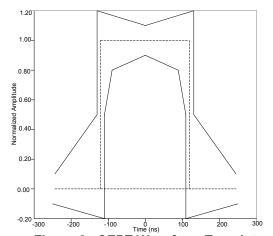


Figure-6 CEPT Waveform Template

Table-5 Built-in Waveform Template Selection

| TS2 | TS1 | TS0 | Service | Clock Rate | Cable Length | Maximum Cable Loss (dB) ⁽¹⁾ | | | | | |
|-----|--|-----|---------|------------|---------------------------------|--|-----|--|--|------------------|-----|
| 0 | 0 | 0 | E1 | 2.048 MHz | 120 Ω /75 Ω Cable | - | | | | | |
| | , and the second | | | 2.0.102 | | - | | | | | |
| 0 | 0 | 1 | | | Reserved | | | | | | |
| 0 | 1 | 0 | | | 1,000,100 | | | | | | |
| 0 | 1 | 1 | | | 0-133 ft. ABAM | 0.6 | | | | | |
| 1 | 0 | 0 | | 1.544 MHz | 1.544 MHz | | | | | 133-266 ft. ABAM | 1.2 |
| 1 | 0 | 1 | T1 | | | 266-399 ft. ABAM | 1.8 | | | | |
| 1 | 1 | 0 | | | 399-533 ft. ABAM | 2.4 | | | | | |
| 1 | 1 | 1 | | | 533-655 ft. ABAM | 3.0 | | | | | |

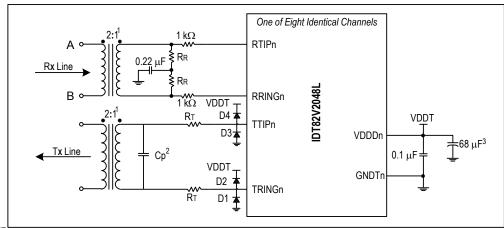
^{1.} Maximum cable loss at 772 kHz.

2.6 LINE INTERFACE CIRCUITRY

The transmit and receive interface RTIPn/RRINGn and TTIPn/TRINGn connections provide a matched interface to the cable. Figure-7 shows the appropriate external components to connect with the cable for one transmit/receive channel. Table-6 summarizes the component values based on the specific application.

Table-6 External Components Values

| Component | | E1 | T1 | | |
|----------------|---|---------------------------|---|--|--|
| Component | 75 Ω Coax | 120 Ω Twisted Pair | 100 Ω Twisted Pair, VDDT = 5.0 V | | |
| R _T | $9.5~\Omega\pm1\%$ | $9.5~\Omega\pm1\%$ | 9.1 Ω ± 1% | | |
| R_R | $9.31~\Omega\pm1\%$ | 15 Ω \pm 1% | 12.4 Ω \pm 1% | | |
| Ср | 22 | 00 pF | 1000 pF | | |
| D1 - D4 | Nihon Inter Electronics - EP05Q03L, 11EQS03L, EC10QS04, EC10QS03L; Motorola - MBR0540T1 | | | | |



NOTE

- 1. Pulse T1124 transformer is recommended to be used in Standard (STD) operating temperature range (0°C to 70°C), while Pulse T1114 transformer is recommended to be used in Extended (EXT) operating temperature range is -40°C to +85°C. See Transformer Specifications Table for details
- 2. Typical value. Adjust for actual board parasitics to obtain optimum return loss.
- 3. Common decoupling capacitor for all VDDT and GNDT pins. One per chip.

Figure-7 External Transmit/Receive Line Circuitry

2.7 TRANSMIT DRIVER POWER SUPPLY

All transmit driver power supplies must be 5.0 V or 3.3 V.

In E1 mode, despite the power supply voltage, the 75 Ω /120 Ω lines are driven through a pair of 9.5 Ω series resistors and a 1:2 transformer.

In T1 mode, only 5.0 V can be selected, 100 Ω lines are driven through a pair of 9.1 Ω series resistors and a 1:2 transformer.

In harsh cable environment, series resistors are required to improve the transmit return loss performance and protect the device from surges coupling into the device.

Table-7 Transformer Specifications⁽¹⁾

| | Electrical Specification @ 25°C | | | | | | | | | |
|-----------|---------------------------------|----------------|-----------------------------|----------|---------------------|----------|-------------------|----------|---------|-----------------------|
| Part | t No. | Turns Ratio (F | Turns Ratio (Pri: sec ± 2%) | | OCL @ 25°C (mH MIN) | | $L_L (\mu H MAX)$ | | F MAX) | Package/Schematic |
| STD Temp. | EXT Temp. | Transmit | Receive | Transmit | Receive | Transmit | Receive | Transmit | Receive | 1 askags/solicillatio |
| T1124 | T1114 | 1:2CT | 1CT:2 | 1.2 | 1.2 | .6 | .6 | 35 | 35 | TOU/3 |

^{1.} Pulse T1124 transformer is recommended to be used in Standard (STD) operating temperature range (0°C to 70°C), while Pulse T1114 transformer is recommended to be used in Extended (EXT) operating temperature range is -40°C to +85°C.

2.8 POWER DRIVER FAILURE MONITOR

An internal power Driver Failure Monitor (DFMON), parallel connected with TTIPn and TRINGn, can detect short circuit failure between TTIPn and TRINGn pins. Bit SCPB in register **GCF** decides whether the output driver short circuit protection is enabled. When the short circuit protection is enabled, the driver output current is limited to a typical value: 180 mAp. Also, register **DF**, **DFI** and **DFM** will be available. When DFMON will detect a short circuit, register **DF** will be set. With a short circuit failure detected, register **DFI** will be set and an interrupt will be generated on pin $\overline{\text{INT}}$.

2.9 TRANSMIT LINE SIDE SHORT CIRCUIT

In E1 or T1 with 5 V VDDT, a pair of 9.5 Ω serial resistors connect with TTIPn and TRINGn pins and limit the output current. In this case, the output current is a limited value which is always lower than the typical line short circuit current 180 mAp, even if the transmit line side is shorted.

Refer to Table-6 External Components Values for details.

2.10 LINE PROTECTION

In transmit side, the Schottky diodes D1~D4 are required to protect the line driver and improve the design robustness. In receive side, the series resistors of 1 k Ω are used to protect the receiver against current surges coupled in the device. The series resistors do not affect the receiver sensitivity, since the receiver impedance is as high as 120 k Ω typically.

2.11 HITLESS PROTECTION SWITCHING (HPS)

The IDT82V2048L transceivers include an output driver with high impedance feature for T1/E1 redundancy applications. This feature reduces the cost of redundancy protection by eliminating external relays. Details of HPS are described in relative Application Note.

2.12 TRANSMIT ALL ONES (TAOS)

In hardware mode, the TAOS mode is set by pulling pin TCLKn high for more than 16 MCLK cycles. In host mode, TAOS mode is set by programming register **TAO**. In addition, automatic TAOS signals are inserted by setting register **ATAO** when Loss of Signal occurs. Note that the TAOS generator adopts MCLK as a timing reference. In order to assure that the output frequency is within specified limits, MCLK must have the applicable stability.

Refer to Figure-8 TAOS Data Path.

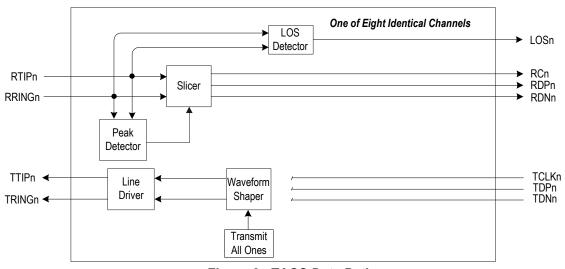


Figure-8 TAOS Data Path

2.13 G.772 MONITORING

The eight channels of IDT82V2048L can all be configured to work as regular transceivers. In applications using only seven channels (channels 1 to 7), channel 0 is configured to non-intrusively monitor any of the other channels' inputs or outputs on the line side. The monitoring is non-intrusive per ITU-T G.772. Figure-9 shows the Monitoring Principle. The receiver path or transmitter path to be monitored is configured by pin MC[3:0] in hardware mode or by **PMON** in host mode.

The signal which is monitored can be observed digitally at the output pin RC0, RDP0 and RDN0. LOS detector is still in use in channel 0 for the monitored signal.

In monitoring mode, a clock and data recovery circuit can be enabled for Remote Loopback operation. In Remote Loopback operation, the signal which is being monitored will be also output on TTIP0 and TRING0 pins. The output signal can then be connected to a standard test equipment for non-intrusive monitoring. RC0 pin will also output the recovered clock (DPLL).

The remote loopback is only available in host mode operation.

To enable the remote loopback, bit 0 in register **RL0** has to be set, and bit 0 in register **e-AFE** has to be cleared. The register setting are: register **RL0** set '01'H, register **e-AFE** set 'FE'H.

For normal operation register **RL0** has to be set '00H' and register **e-AFE** has to be set 'FFH'.

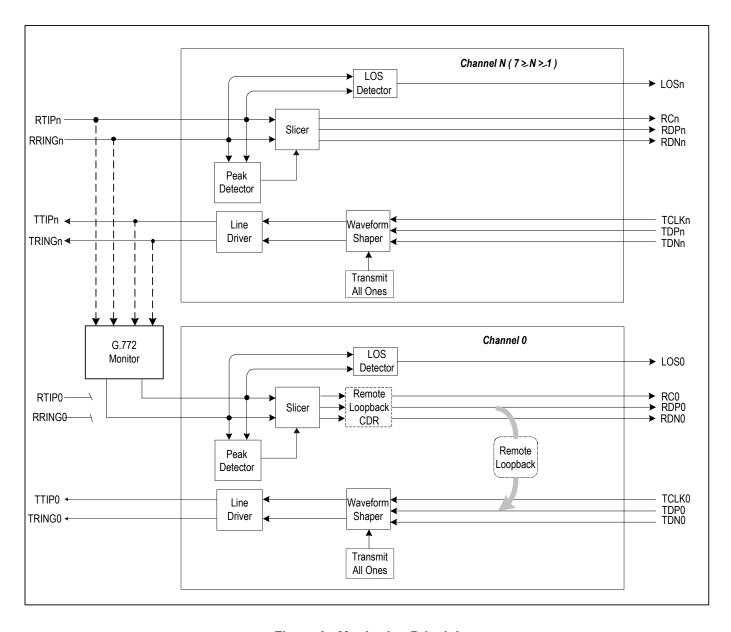


Figure-9 Monitoring Principle

2.14 SOFTWARE RESET

Writing register **RS** will cause software reset by initiating about 1 μs reset cycle. This operation set all the registers to their default value.

2.15 POWER ON RESET

During power up, an internal reset signal sets all the registers to default values. The power-on reset takes at least 10 $\mu s,$ starting from when the power supply exceeds 2/3 VDDA.

2.16 POWER DOWN

Each transmit channel will be powered down by pulling pin TCLKn low for more than 64 MCLK cycles (if MCLK is available) or about 30 μs (if MCLK is not available). In host mode, each transmit channel will also be powered down by setting bit TPDNn in register **e-TPDN** to '1'.

All the receivers will be powered down when MCLK is low. When MCLK is clocked or high, setting bit RPDNn in register **e-RPDN** to '1' will configure the corresponding receiver to be powered down.

2.17 INTERFACE WITH 5 V LOGIC

The IDT82V2048L can interface directly with 5 V TTL family devices. The internal input pads are tolerant to 5 V output from TTL and CMOS family devices.

2.18 HOST INTERFACE

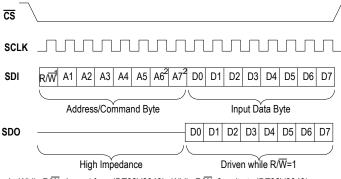
The host interface provides access to read and write the registers in the device. The interface consists of serial host interface and parallel host interface. By pulling pin MODE2 to VDDIO/2 or high, the device can be set to work in serial mode and in parallel mode respectively. In host mode operation, expanded register **e-FAE** has to be set to 'FFH' for proper device operation. See Expanded Register Description on page 28 for details.

Table-8 Parallel Host Interface Pins

2.18.1 PARALLEL HOST INTERFACE

The interface is compatible with Motorola and Intel host. Pins MODE[1:0] are used to select the operating mode of the parallel host interface. When pin MODE1 is pulled low, the host uses separate address bus and data bus. When high, multiplexed address/data bus is used. When pin MODE0 is pulled low, the parallel host interface is configured for Motorola compatible hosts. When pin MODE0 is pulled high, the parallel host interface is configured for Intel compatible hosts. See Table-1 Pin Description for more details. The host interface pins in each operation mode is tabulated in Table-8:

| MODE[2:0] | Host Interface | Generic Control, Data and Output Pin |
|-----------|------------------------------------|--|
| 100 | Non-multiplexed Motorola interface | $\overline{\text{CS}}$, $\overline{\text{ACK}}$, $\overline{\text{DS}}$, R/\overline{W} , $\overline{\text{AS}}$, A[4:0], D[7:0], $\overline{\text{INT}}$ |
| 101 | Non-multiplexed Intel interface | CS, RDY, WR, RD, ALE, A[4:0], D[7:0], INT |
| 110 | Multiplexed Motorola interface | $\overline{\text{CS}}$, $\overline{\text{ACK}}$, $\overline{\text{DS}}$, $\overline{\text{R/W}}$, $\overline{\text{AS}}$, $\overline{\text{AD}}$ [7:0], $\overline{\text{INT}}$ |
| 111 | Multiplexed Intel interface | CS, RDY, WR, RD, ALE, AD[7:0], INT |



- 1. While R/W=1, read from IDT82V2048L; While R/W=0, write to IDT82V2048L.
- 2. Ignored.

Figure-10 Serial Host Mode Timing

2.18.2 SERIAL HOST INTERFACE

By pulling pin MODE2 to VDDIO/2, the device operates in the serial host Mode. In this mode, the registers are accessible through a 16-bit word which contains an 8-bit command/address byte (bit R/\overline{W} and 5-address-bit A1~A5, A6 and A7 bits are ignored) and a subsequent 8-bit data byte (D7~D0), as shown in Figure-10. When bit R/\overline{W} is set to '1', data is read out from pin SDO. When bit R/\overline{W} is set to '0', data on pin SDI is written into the register whose address is indicated by address bits A5~A1. Refer to Figure-10 Serial Host Mode Timing.

2.19 INTERRUPT HANDLING

2.19.1 INTERRUPT SOURCES

There are two kinds of interrupt sources:

- Status change in register LOS. The analog/digital loss of signal detector continuously monitors the received signal to update the specific bit in register LOS which indicates presence or absence of a LOS condition.
- Status change in register **DF**. The automatic power driver circuit continuously monitors the output drivers signal to update the specific bit in register **DFM** which indicates presence or absence of an output driver short circuit condition.

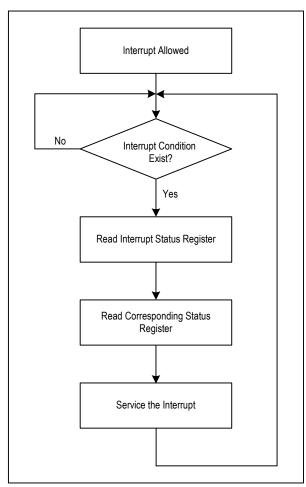


Figure-11 Interrupt Service Routine

2.19.2 INTERRUPT ENABLE

The IDT82V2048L provides a latched interrupt output ($\overline{\text{INT}}$) and the two kinds of interrupts are all reported by this pin. When the Interrupt Mask register: **LOSM** and **DFM**, are set to '1', the Interrupt Status register: **LOSI** and **DFI**, are enabled respectively. Whenever there is a transition ('0' to '1' or '1' to '0') in the corresponding status register, the Interrupt Status register will change into '1', which means an interrupt occurs, and there will be a high to low transition on $\overline{\text{INT}}$ pin. An external pull-up resistor of approximately 10 k Ω is required to support the wire-OR operation of $\overline{\text{INT}}$. When any of the two Interrupt Mask registers is set to '0' (the power-on default value is '0'), the corresponding Interrupt Status register is disabled and the transition on status register is ignored.

2.19.3 INTERRUPT CLEARING

When an interrupt occurs, the Interrupt Status registers: **LOSI** and **DFI**, are read to identify the interrupt source. These registers will be cleared to '0' after the corresponding status registers: **LOS** and **DF** are read. The Status registers will be cleared once the corresponding conditions are met.

Pin $\overline{\text{INT}}$ is pulled high when there is no pending interrupt left. The interrupt handling in the interrupt service routine is shown in Figure-11.

3 PROGRAMMING INFORMATION

3.1 REGISTER LIST AND MAP

There are 18 primary registers (including an Address Pointer Control Register and 4 expanded registers in the device).

Whatever the control interface is, 5 address bits are used to set the registers. In non-multiplexed parallel interface mode, the five dedicated address bits are A[4:0]. In multiplexed parallel interface mode, AD[4:0] carries the address information. In serial interface mode, A[5:1] are used to address the register.

Table-9 Primary Register List

The Register **ADDP**, addressed as 11111 or 1F Hex, switches between primary registers bank and expanded registers bank.

By setting register **ADDP** to 'AAH', the 5 address bits point to the expanded register bank, that is, 4 expanded registers are available. By clearing register **ADDP**, the primary registers are available.

3.2 RESERVED AND TEST REGISTERS

Primary Registers, whose address are 01H, 0CH, 13H to 1EH, are reserved. Expanded registers, whose address are 00H, 01H, 05H, 06H, 08H to 0FH, are reserved. Expanded registers, whose address are 10H to 1EH, are used for test and must be set to '0' (default).

| | Address | | Dagiatas | R/W | Evulonation |
|-----|------------------------|--------------------------|----------|-------|---|
| Hex | Serial Interface A7-A1 | Parallel Interface A7-A0 | Register | IK/VV | Explanation |
| 00 | XX00000 | XXX00000 | ID | R | Device ID Register |
| 01 | XX00001 | XXX00001 | | • | Reserved |
| 02 | XX00010 | XXX00010 | RL0 | R/W | G.772 Monitoring, Remote Loopback Configuration Register |
| 03 | XX00011 | XXX00011 | TAO | R/W | Transmit All Ones Configuration Register |
| 04 | XX00100 | XXX00100 | LOS | R | Loss of Signal Status Register |
| 05 | XX00101 | XXX00101 | DF | R | Driver Fault Status Register |
| 06 | XX00110 | XXX00110 | LOSM | R/W | LOS Interrupt Mask Register |
| 07 | XX00111 | XXX00111 | DFM | R/W | Driver Fault Interrupt Mask Register |
| 08 | XX01000 | XXX01000 | LOSI | R | LOS Interrupt Status Register |
| 09 | XX01001 | XXX01001 | DFI | R | Driver Fault Interrupt Status Register |
| 0A | XX01010 | XXX01010 | RS | W | Software Reset Register |
| 0B | XX01011 | XXX01011 | PMON | R/W | Performance Monitor Configuration Register |
| 0C | XX01100 | XXX01100 | | | Reserved |
| 0D | XX01101 | XXX01101 | LAC | R/W | LOS/AIS Criteria Configuration Register |
| 0E | XX01110 | XXX01110 | ATAO | R/W | Automatic TAOS Configuration Register |
| 0F | XX01111 | XXX01111 | GCF | R/W | Global Configuration Register |
| 10 | XX10000 | XXX10000 | TSIA | R/W | Indirect Address Register for Transmit Template Select |
| 11 | XX10001 | XXX10001 | TS | R/W | Transmit Template Select Register |
| 12 | XX10010 | XXX10010 | OE | R/W | Output Enable Configuration Register |
| 13 | XX10011 | XXX10011 | | | |
| 14 | XX10100 | XXX10100 | | | |
| 15 | XX10101 | XXX10101 | | | |
| 16 | XX10110 | XXX10110 | | | |
| 17 | XX10111 | XXX10111 | | | |
| 18 | XX11000 | XXX11000 | | | Reserved |
| 19 | XX11001 | XXX11001 | | | Neserveu |
| 1A | XX11010 | XXX11010 | | | |
| 1B | XX11011 | XXX11011 | | | |
| 1C | XX11100 | XXX11100 | | | |
| 1D | XX11101 | XXX11101 | | | |
| 1E | XX11110 | XXX11110 | | | |
| 1F | XX11111 | XXX11111 | ADDP | R/W | Address pointer control Register for switching between primary register bank and expanded register bank |

Table-10 Expanded (Indirect Address Mode) Register List

| | Addre | ss | Register | R/W | Explanation |
|-----|------------------------|--------------------------|----------|-----|---|
| Hex | Serial Interface A7-A1 | Parallel Interface A7-A0 | 3 | | _ |
| 00 | XX00000 | XXX00000 | | | Descried |
| 01 | XX00001 | XXX00001 | | | Reserved |
| 02 | XX00010 | XXX00010 | e-AFE | R/W | AFE Enable Register |
| 03 | XX00011 | XXX00011 | e-RPDN | R/W | Receiver n Powerdown Enable/Disable Register |
| 04 | XX00100 | XXX00100 | e-TPDN | R/W | Transmitter n Powerdown Enable/Disable Register |
| 05 | XX00101 | XXX00101 | | | · |
| 06 | XX00110 | XXX00110 | | | Reserved |
| 07 | XX00111 | XXX00111 | e-EQUA | R/W | Enable Equalizer Enable/Disable Register |
| 08 | XX01000 | XXX01000 | | | , |
| 09 | XX01001 | XXX01001 | | | |
| 0A | XX01010 | XXX01010 | | | |
| 0B | XX01011 | XXX01011 | | | Reserved |
| 0C | XX01100 | XXX01100 | | | Reserved |
| 0D | XX01101 | XXX01101 | | | |
| 0E | XX01110 | XXX01110 | | | |
| 0F | XX01111 | XXX01111 | | | |
| 10 | XX10000 | XXX10000 | | | |
| 11 | XX10001 | XXX10001 | | | |
| 12 | XX10010 | XXX10010 | | | |
| 13 | XX10011 | XXX10011 | | | |
| 14 | XX10100 | XXX10100 | | | |
| 15 | XX10101 | XXX10101 | | | |
| 16 | XX10110 | XXX10110 | | | |
| 17 | XX10111 | XXX10111 | | | Test |
| 18 | XX11000 | XXX11000 | | | |
| 19 | XX11001 | XXX11001 | | | |
| 1A | XX11010 | XXX11010 | | | |
| 1B | XX11011 | XXX11011 | | | |
| 1C | XX11100 | XXX11100 | | | |
| 1D | XX11101 | XXX11101 | | | |
| 1E | XX11110 | XXX11110 | | | |
| 1F | XX11111 | XXX11111 | ADDP | R/W | Address pointer control register for switching between primary register bank and expanded register bank |

Table-11 Primary Register Map

| Register | Address R/W Default | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|----------|---------------------------|---------------------------------------|---------------|---------------|---------------|---------------|---------------|---------------|---------------|
| | 00H | ID 7 | ID 6 | ID 5 | ID 4 | ID 3 | ID 2 | ID 1 | ID 0 |
| ID | R | R | R | R | R | R | R | R | R |
| | Default | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| DI O | 02H | - | - | - | - | - | - | - | RL0 |
| RL0 | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| TAO | 03H | TAO 7 | TAO 6 | TAO 5 | TAO 4 | TAO 3 | TAO 2 | TAO 1 | TAO 0 |
| IAO | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| LOS | 04H | LOS 7 | LOS 6 | LOS 5 | LOS 4 | LOS 3 | LOS 2 | LOS 1 | LOS 0 |
| LOO | R | R 0 | R 0 | R 0 | R 0 | R 0 | R 0 | R 0 | R 0 |
| | Default | | | · | | | | | |
| DF | 05H | DF 7 | DF 6 | DF 5 | DF 4 | DF 3 | DF 2 | DF 1 | DF 0 |
| Di | R Default | R 0 | R 0 | R 0 | R 0 | R 0 | R 0 | R 0 | R 0 |
| | | · · · · · · · · · · · · · · · · · · · | | <u> </u> | | | · | <u> </u> | - |
| LOSM | 06H R/W | LOSM 7 R/W | LOSM 6 R/W | LOSM 5 R/W | LOSM 4 R/W | LOSM 3 R/W | LOSM 2 R/W | LOSM 1 R/W | LOSM 0 R/W |
| 200 | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | 07H | DFM 7 | DFM 6 | DFM 5 | DFM 4 | DFM 3 | DFM 2 | DFM 1 | DFM 0 |
| DFM | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | 08H | LOSI 7 | LOSI 6 | LOSI 5 | LOSI 4 | LOSI 3 | LOSI 2 | LOSI 1 | LOSI 0 |
| LOSI | R | R | R | R | R | R | R | R | R |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | 09H | DFI 7 | DFI 6 | DFI 5 | DFI 4 | DFI 3 | DFI 2 | DFI 1 | DFI 0 |
| DFI | R | R | R | R | R | R | R | R | R |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | 0AH | RS 7 | RS 6 | RS 5 | RS 4 | RS 3 | RS 2 | RS 1 | RS 0 |
| RS | W | W | W | W | W | W | W | W | W |
| | Default | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| | 0BH | - | - | - | - | MC 3 | MC 2 | MC 1 | MC 0 |
| PMON | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | 0DH | LAC 7 | LAC 6 | LAC 5 | LAC 4 | LAC 3 | LAC 2 | LAC 1 | LAC 0 |
| LAC | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 4740 | 0EH | ATAO 7 | ATAO 6 | ATAO 5 | ATAO 4 | ATAO 3 | ATAO 2 | ATAO 1 | ATAO 0 |
| ATAO | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 005 | 0FH | - | - | SCPB | - | - | - | - | - |
| GCF | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| TCIA | 10 Hex | | | | - | | TSIA 2 | TSIA 1 | TSIA 0 |
| TSIA | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Table-11 Primary Register Map (Continued)

| Register | Address R/W Default | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|----------|---------------------------|--------|--------|--------|--------|--------|--------|--------|--------|
| | 11 Hex | - | - | - | - | - | TS 2 | TS 1 | TS 0 |
| TS | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | 12 Hex | OE 7 | OE 6 | OE 5 | OE 4 | OE 3 | OE 2 | OE 1 | OE 0 |
| OE | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | 1F Hex | ADDP 7 | ADDP 6 | ADDP 5 | ADDP 4 | ADDP 3 | ADDP 2 | ADDP 1 | ADDP 0 |
| ADDP | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Table-12 Expanded (Indirect Address Mode) Register Map

| Register | Address R/W Default | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|----------------------|---------------------------|--------|--------|--------|--------|--------|--------|--------|--------|
| e-AFE ⁽¹⁾ | 02H | AFE 7 | AFE 6 | AFE 5 | AFE 4 | AFE 3 | AFE 2 | AFE 1 | AFE 0 |
| | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| e-RPDN | 03H | RPDN 7 | RPDN 6 | RPDN 5 | RPDN 4 | RPDN 3 | RPDN 2 | RPDN 1 | RPDN 0 |
| | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| e-TPDN | 04H | TPDN 7 | TPDN 6 | TPDN 5 | TPDN 4 | TPDN 3 | TPDN 2 | TPDN 1 | TPDN 0 |
| | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| e-EQUA | 07H | EQUA 7 | EQUA 6 | EQUA 5 | EQUA 4 | EQUA 3 | EQUA 2 | EQUA 1 | EQUA 0 |
| | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| ADDP | 1FH | ADDP 7 | ADDP 6 | ADDP 5 | ADDP 4 | ADDP 3 | ADDP 2 | ADDP 1 | ADDP 0 |
| | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

^{1.} In host mode, register e-AFE has to be set to 'FFH' for proper device operation. See e-AFE: AFE Enable Selection Register (R/W, Expanded Address = 02H) on page 28 for more details.

3.3 REGISTER DESCRIPTION

3.3.1 PRIMARY REGISTERS

ID: Device ID Register (R, Address = 00H)

| Symbol | Position | Default | Description |
|---------|----------|---------|--|
| ID[7:0] | ID.7-0 | 10H | An 8-bit word is pre-set into the device as the identification and revision number. This number is different with the functional changes and is mask programmed. |

RL0: G.772 Monitoring, Remote Loopback Configuration Register (R/W, Address = 02H)

| Symbol | Position | Default | Description |
|--------|----------|---------|--|
| - | RL.7-1 | 0000000 | Reserved |
| RL[0] | RL.0 | 0 | 0 = Normal operation. (Default) 1 = Remote loopback enabled. |

TAO: Transmit All Ones Configuration Register (R/W, Address = 03H)

| Symbol | Position | Default | Description |
|----------|----------|---------|--|
| TAO[7:0] | TAO.7-0 | 00H | 0 = Normal operation. (Default) 1 = Transmit all ones. |

LOS: Loss of Signal Status Register (R, Address = 04H)

| Symbol | Position | Default | Description |
|----------|----------|---------|--|
| LOS[7:0] | LOS.7-0 | 00H | 0 = Normal operation. (Default) 1 = Loss of signal detected. |

DF: Driver Fault Status Register (R, Address = 05H)

| Symbol | Position | Default | Description |
|---------|----------|---------|--|
| DF[7:0] | DF.7-0 | 00H | 0 = Normal operation. (Default) 1 = Driver fault detected. |

LOSM: Loss of Signal Interrupt Mask Register (R/W, Address = 06H)

| Symbol | Position | Default | Description | |
|-----------|----------|---------|---|--|
| LOSM[7:0] | LOSM.7-0 | 00H | 0 = LOS interrupt is not allowed. (Default) 1 = LOS interrupt is allowed. | |

DFM: Driver Fault Interrupt Mask Register (R/W, Address = 07H)

| Ī | Symbol | Position | Default | Description |
|---|----------|----------|---------|---|
| | DFM[7:0] | DFM.7-0 | 00H | 0 = Driver fault interrupt not allowed. (Default) 1 = Driver fault interrupt allowed. |

LOSI: Loss of Signal Interrupt Status Register (R, Address = 08H)

| Symbol | Position | Default | Description |
|-----------|----------|---------|--|
| LOSI[7:0] | LOSI.7-0 | 00H | 0 = (Default). Or after a LOS read operation. 1 = Any transition on LOSn (Corresponding LOSMn is set to '1'). |

DFI: Driver Fault Interrupt Status Register (R, Address = 09H)

| Symbol | Position | Default | Description |
|----------|----------|---------|---|
| DFI[7:0] | DFI.7-0 | 00H | 0 = (Default). Or after a DF read operation. 1 = Any transition on DFn (Corresponding DFMn is set to '1'). |

RS: Software Reset Register (W, Address = 0AH)

| Symbol | Position | Default | Description |
|---------|----------|---------|---|
| RS[7:0] | RS.7-0 | FFH | Writing to this register will not change the content in this register but initiate a 1 µs reset cycle, which means all the registers in the device are set to their default values. |

PMON: Performance Monitor Configuration Register (R/W, Address = 0BH)

| Symbol | Position | Default | Description | | | |
|---------|----------|---------|--|--|--|--|
| - | PMON.7-4 | 0000 | 0 = Normal operation. (Default) 1 = Reserved. | | | |
| MC[3:0] | PMON.3-0 | 0000 | 0000 = Normal operation without monitoring (Default) 0001 = Monitor Receiver 1 0010 = Monitor Receiver 2 0011 = Monitor Receiver 3 0100 = Monitor Receiver 4 0101 = Monitor Receiver 5 0110 = Monitor Receiver 6 0111 = Monitor Receiver 7 1000 = Normal operation without monitoring 1001 = Monitor Transmitter 1 1010 = Monitor Transmitter 2 1011 = Monitor Transmitter 3 1100 = Monitor Transmitter 4 1101 = Monitor Transmitter 5 1110 = Monitor Transmitter 6 1111 = Monitor Transmitter 7 | | | |

LAC: LOS/AIS Criteria Configuration Register (R/W, Address = 0DH)

| Symbol | Position | Default | Description |
|----------|----------|---------|---|
| LAC[7:0] | LAC.7-0 | 00H | For E1 mode, the criterion is selected as below: 0 = G.775 (Default) 1 = ETSI 300 233 For T1 mode, the criterion meets T1.231. |

ATAO: Automatic TAOS Configuration Register (R/W, Address = 0EH)

| Symbol | Position | Default | Description |
|-----------|----------|---------|--|
| ATAO[7:0] | ATAO.7-0 | 00H | 0 = No automatic transmit all ones. (Default) 1 = Automatic transmit all ones to the line side during LOS. |

GCF: Global Configuration Register (R/W, Address = 0FH)

| Symbol | Position | Default | Description | |
|--------|----------|---------|--|--|
| - | GCF.7-6 | 00 | 0 = Normal operation. 1 = Reserved. | |
| SCPB | GCF.5 | 0 | 0 = Short circuit protection is enabled. 1 = Short circuit protection is disabled. | |
| - | GCF.4-0 | 00000 | 0 = Normal operation. 1 = Reserved. | |

TSIA: Indirect Address Register for Transmit Template Select Registers (R/W, Address = 10H)

| Symbol | Position | Default | Description | |
|-----------|----------|---------|---|--|
| - | TSIA.7-3 | 00000 | 0 = Normal operation. (Default) 1 = Reserved. | |
| TSIA[2:0] | TSIA.2-0 | 000 | 000 = Channel 0 (Default) 001 = Channel 1 010 = Channel 2 011 = Channel 3 100 = Channel 4 101 = Channel 5 110 = Channel 6 111 = Channel 7 | |

TS: Transmit Template Select Register (R/W, Address = 11H)

| Symbol | Position | Default | | | Description |
|---------|----------|------------|---------------------------------------|-------------------------------|--|
| - | TS.7-3 | 00000 | 0 = Normal operation 1 = Reserved. | . (Default) | |
| | | TS.2-0 000 | TS[2:0] pins select or | ne of eight built-in transmit | template for different applications. |
| | | | TS[2:0] | Mode | Cable Length |
| | | | 000 | E1 | 75 Ω coaxial cable/120 Ω twisted pair cable. |
| TS[2-0] | TS 2-0 | | 001 010 | | Reserved. |
| [] | | | 011 | T1 | 0 - 133 ft. |
| | | | 100 | T1 | 133 - 266 ft. |
| | | | 101 | T1 | 266 - 399 ft. |
| | | | 110 | T1 | 399 - 533 ft. |
| | | | 111 | T1 | 533 - 655 ft. |

OE: Output Enable Configuration Register (R/W, Address = 12H)

| ſ | Symbol | Position | Default | Description | |
|---|---------|----------|---------|---|--|
| | OE[7:0] | OE.7-0 | 00H | 0 = Transmit drivers enabled. (Default) 1 = Transmit drivers in high impedance state. | |

ADDP: Address Pointer Control Register (R/W, Address = 1F H)

| Symbol | Position | Default | Description |
|-----------|----------|---------|---|
| ADDP[7:0] | ADDP.7-0 | 00H | Two kinds of configuration in this register can be set to switch between primary register bank and expanded register bank. When power up, the address pointer will point to the top address of primary register bank automatically. 00H = The address pointer points to the top address of primary register bank (default). AAH = The address pointer points to the top address of expanded register bank. |

3.3.2 EXPANDED REGISTER DESCRIPTION

e-AFE: AFE Enable Selection Register (R/W, Expanded Address = 02H)

| Symbol | Position | Default | Description |
|----------|----------|--------------------|--|
| AFE[7:0] | AFE.7-0 | 00H ⁽¹⁾ | 0 = Reserved (Default) Note: For remote loopback operation in G.772 monitoring mode, bit 0 can be set to '0'. 1 = AFE mode enabled. |

¹ In host mode, AFE[7:0] bits must be set to 'FFH' for normal device operation.

e-RPDN: Receiver n Powerdown Register (R/W, Expanded Address = 03H)

| Symbol | Position | Default | Description | | | |
|-----------|----------|---------|---|--|--|--|
| RPDN[7:0] | RPDN.7-0 | 00H | 0 = Normal operation. (Default) 1 = Receiver n is powered down. | | | |

e-TPDN: Transmitter n Powerdown Register (R/W, Expanded Address = 04H)

| Symbol | Position | Default | Description |
|-----------|----------|---------|---|
| TPDN[7:0] | TPDN.7-0 | 00H | 0 = Normal operation. (Default) 1 = Transmitter n is powered down ⁽¹⁾ (the corresponding transmit output driver enters a low power high impedance mode). |

¹ Transmitter n is powered down when either pin TCLKn is pulled low or TPDNn is set to '1'

e-EQUA: Receive Equalizer Enable/Disable Register (R/W, Expanded Address = 07H)

| Symbol | Position | Default | Description | | |
|-----------|----------|---------|--|--|--|
| EQUA[7:0] | EQUA.7-0 | 00H | 0 = Normal operation. (Default) 1 = Equalizer in Receiver n is enabled, which can improve the receive performance when transmission length is more than 200 m. | | |

4 IEEE STD 1149.1 JTAG TEST ACCESS PORT

The IDT82V2048L supports the digital Boundary Scan Specification as described in the IEEE 1149.1 standards.

The boundary scan architecture consists of data and instruction registers plus a Test Access Port (TAP) controller. Control of the TAP is achieved through signals applied to the TMS and TCK pins. Data is shifted into the registers via the TDI pin, and shifted out of the registers via the TDO pin. JTAG test data are clocked at a rate determined by JTAG test clock.

The JTAG boundary scan registers includes BSR (Boundary Scan Register), IDR (Device Identification Register), BR (Bypass Register) and IR (Instruction Register). These will be described in the following pages. Refer to Figure-12 for architecture.

4.1 JTAG INSTRUCTIONS AND INSTRUCTION REGISTER (IR)

The IR with instruction decode block is used to select the test to be executed or the data register to be accessed or both.

The instructions are shifted in LSB first to this 3-bit register. See Table-13 Instruction Register Description on page 30 for details of the codes and the instructions related.

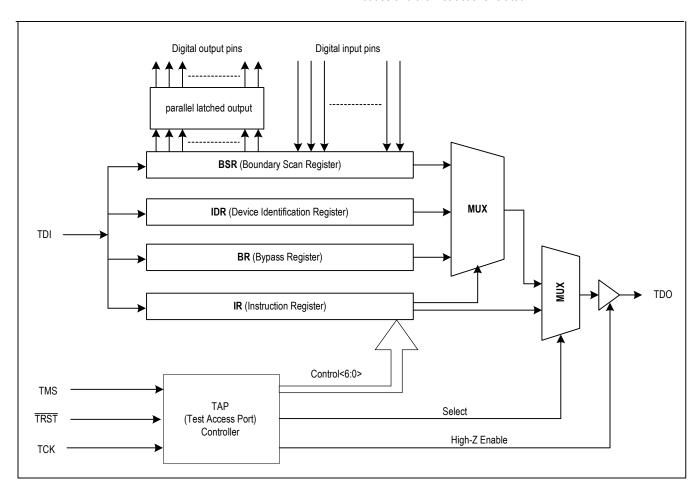


Figure-12 JTAG Architecture

Table-13 Instruction Register Description

| IR Code | Instruction | Comments |
|---------|----------------|--|
| 000 | Extest | The external test instruction allows testing of the interconnection to other devices. When the current instruction is the EXTEST instruction, the boundary scan register is placed between TDI and TDO. The signal on the input pins can be sampled by loading the boundary scan register using the Capture-DR state. The sampled values can then be viewed by shifting the boundary scan register using the Shift-DR state. The signal on the output pins can be controlled by loading patterns shifted in through input TDI into the boundary scan register using the Update-DR state. |
| 100 | Sample/Preload | The sample instruction samples all the device inputs and outputs. For this instruction, the boundary scan register is placed between TDI and TDO. The normal path between IDT82V2048L logic and the I/O pins is maintained. Primary device inputs and outputs can be sampled by loading the boundary scan register using the Capture-DR state. The sampled values can then be viewed by shifting the boundary scan register using the Shift-DR state. |
| 110 | Idcode | The identification instruction is used to connect the identification register between TDI and TDO. The device's identification code can then be shifted out using the Shift-DR state. |
| 111 | Bypass | The bypass instruction shifts data from input TDI to output TDO with one TCK clock period delay. The instruction is used to bypass the device. |

Table-14 Device Identification Register Description

| Bit No. | Comments |
|---------|-----------------|
| 0 | Set to '1' |
| 1~11 | Producer Number |
| 12~27 | Part Number |
| 28~31 | Device Revision |

4.2 JTAG DATA REGISTER

4.2.1 DEVICE IDENTIFICATION REGISTER (IDR)

The IDR can be set to define the producer number, part number and the device revision, which can be used to verify the proper version or revision number that has been used in the system under test. The IDR is 32 bits long and is partitioned as in Table-14. Data from the IDR is shifted out to TDO LSB first.

Table-15 Boundary Scan Register Description

| Bit No. | Bit Symbol | Pin Signal | Туре | Comments |
|---------|------------|------------|------|----------|
| 0 | POUT0 | D0 | I/O | |
| 1 | PIN0 | D0 | I/O | |
| 2 | POUT1 | D1 | I/O | |
| 3 | PIN1 | D1 | I/O | |
| 4 | POUT2 | D2 | I/O | |
| 5 | PIN2 | D2 | I/O | |
| 6 | POUT3 | D3 | I/O | |
| 7 | PIN3 | D3 | I/O | |
| 8 | POUT4 | D4 | I/O | |
| 9 | PIN4 | D4 | I/O | |
| 10 | POUT5 | D5 | I/O | |
| 11 | PIN5 | D5 | I/O | |
| 12 | POUT6 | D6 | I/O | |
| 13 | PIN6 | D6 | I/O | |
| 14 | POUT7 | D7 | I/O | |
| 15 | PIN7 | D7 | I/O | |

4.2.2 BYPASS REGISTER (BR)

The BR consists of a single bit. It can provide a serial path between the TDI input and TDO output, bypassing the BSR to reduce test access times.

4.2.3 BOUNDARY SCAN REGISTER (BSR)

The BSR can apply and read test patterns in parallel to or from all the digital I/O pins. The BSR is a 98 bits long shift register and is initialized and read using the instruction EXTEST or SAMPLE/PRELOAD. Each pin is related to one or more bits in the BSR. Please refer to Table-15 for details of BSR bits and their functions.

Table-15 Boundary Scan Register Description (Continued)

| 16 | Bit No. | Bit Symbol | Pin Signal | Туре | Comments |
|--|---------|------------|------------|------|--|
| 16 | | | J.g | -71 | |
| 18 | 16 | | | - | When '0', the pins are configured as outputs. The output values to the pins are set in POUT 7~0. |
| 19 | | | | I | |
| 20 | | | | I | |
| 21 | | | | I | |
| A | | | | 0 | |
| A | | | | 0 | |
| August A | 22 | RDN1 | RDN1 | 0 | |
| 25 | | | | - | When '0', the outputs are enabled on the pins. |
| 26 | | | | 0 | |
| 27 | | | | I | |
| RCO | | | | 1 | |
| RDP0 | | | | 1 | |
| A | | | | | |
| A | | | | | |
| 31 | 30 | RDN0 | RDN0 | 0 | |
| 33 | 31 | HZEN0 | N/A | - | When '0', the outputs are enabled on the pins. |
| 34 | 32 | LOS0 | LOS0 | 0 | |
| 35 | 33 | MODE1 | MODE1 | 1 | |
| 36 | 34 | LOS3 | LOS3 | 0 | |
| A | 35 | RDN3 | RDN3 | 0 | |
| 37 | 36 | RDP3 | RDP3 | 0 | |
| 39 | | | | - | When '0', the outputs are enabled on the pins. |
| 40 | | | | 0 | |
| 1 | 39 | | | I | |
| 42 | | | | - 1 | |
| 43 | | | | - 1 | |
| A4 | | | | 0 | |
| HZEN2 | | | | 0 | |
| HZEN2 | 44 | RDP2 | RDP2 | 0 | |
| 47 | 45 | HZEN2 | | - | When '0', the outputs are enabled on the pins. |
| 48 | | | | 0 | |
| 49 TCLK2 I 50 INT INT O 51 ACK ACK O 52 SDORDYS N/A - Control pin ACK. When '0', the output is enabled on pin ACK. When '1', the pin is in high impedance. 53 WRB DS I 54 RDB R/W I | 47 | | | I | |
| 50 INT INT O 51 ACK ACK O 52 SDORDYS N/A - Control pin ACK. When '0', the output is enabled on pin ACK. When '1', the pin is in high impedance. 53 WRB DS I 54 RDB R/W I | | | | I | |
| 51 ACK ACK O 52 SDORDYS N/A - Control pin ACK. When '0', the output is enabled on pin ACK. When '1', the pin is in high impedance. 53 WRB DS I 54 RDB R/W I | | | TCLK2 | I | |
| SDORDYS N/A - Control pin \(\overline{ACK} \) When '0', the output is enabled on pin \(\overline{ACK} \) When '1', the pin is in high impedance. | 50 | INT | ĪNT | 0 | |
| 52 SDORDYS N/A - When '0', the output is enabled on pin ACK. When '1', the pin is in high impedance. 53 WRB DS I 54 RDB R/W I | 51 | ACK | ĀCK | 0 | |
| 54 RDB R/W I | | | | - | When '0', the output is enabled on pin ACK. |
| | 53 | WRB | DS | I | |
| 55 ALE ALE I | 54 | RDB | R/W | I | |
| | 55 | ALE | ALE | I | |

Table-15 Boundary Scan Register Description (Continued)

| Bit No. | Bit Symbol | Pin Signal | Туре | Comments |
|---------|------------|------------|------|---|
| 56 | CSB | <u>CS</u> | j. | |
| 57 | MODE0 | MODE0 | I | |
| 58 | TCLK5 | TCLK5 | ı | |
| 59 | TDP5 | TDP5 | ı | |
| 60 | TDN5 | TDN5 | ı | |
| 61 | RC5 | RC5 | 0 | |
| 62 | RDP5 | RDP5 | 0 | |
| 63 | RDN5 | RDN5 | 0 | |
| 64 | HZEN5 | N/A | - | Controls pin RDP5, RDN5 and RC5. When '0', the outputs are enabled on the pins. When '1', the pins are in high impedance. |
| 65 | LOS5 | LOS5 | 0 | |
| 66 | TCLK4 | TCLK4 | ı | |
| 67 | TDP4 | TDP4 | ı | |
| 68 | TDN4 | TDN4 | ı | |
| 69 | RC4 | RC4 | 0 | |
| 70 | RDP4 | RDP4 | 0 | |
| 71 | RDN4 | RDN4 | 0 | |
| 72 | HZEN4 | N/A | - | Controls pin RDP4, RDN4 and RC4. When '0', the outputs are enabled on the pins. When '1', the pins are in high impedance. |
| 73 | LOS4 | LOS4 | 0 | |
| 74 | OE | OE | ı | |
| 75 | CLKE | CLKE | ı | |
| 76 | LOS7 | LOS7 | 0 | |
| 77 | RDN7 | RDN7 | 0 | |
| 78 | RDP7 | RDP7 | 0 | |
| 79 | HZEN7 | N/A | - | Controls pin RDP7, RDN7 and RC7. When '0', the outputs are enabled on the pins. When '1', the pins are in high impedance. |
| 80 | RC7 | RC7 | 0 | |
| 81 | TDN7 | TDN7 | ı | |
| 82 | TDP7 | TDP7 | ı | |
| 83 | TCLK7 | TCLK7 | ı | |
| 84 | LOS6 | LOS6 | 0 | |
| 85 | RDN6 | RDN6 | 0 | |
| 86 | RDP6 | RDP6 | 0 | |
| 87 | HZEN6 | N/A | - | Controls pin RDP6, RDN6 and RC6. When '0', the outputs are enabled on the pins. When '1', the pins are in high impedance. |
| 88 | RC6 | RC6 | 0 | |
| 89 | TDN6 | TDN6 | ı | |
| 90 | TDP6 | TDP6 | I | |
| 91 | TCLK6 | TCLK6 | I | |
| 92 | MCLK | MCLK | I | |
| 93 | MODE2 | MODE2 | I | |
| 94 | A4 | A4 | I | |
| 95 | A3 | A3 | I | |
| 96 | A2 | A2 | I | |
| 97 | A1 | A1 | I | |
| 98 | A0 | A0 | I | |
| | | 1 | | |

4.3 TEST ACCESS PORT CONTROLLER

The TAP controller is a 16-state synchronous state machine. Figure-13 shows its state diagram A description of each state follows. Note that the figure contains two main branches to access either the data or instruction registers. The value shown next to each state transition in this figure states the value present at TMS at each rising edge of TCK. Refer to Table-16 for details of the state description.

Table-16 TAP Controller State Description

| State | Description |
|------------------|---|
| Test Logic Reset | In this state, the test logic is disabled. The device is set to normal operation. During initialization, the device initializes the instruction register with the IDCODE instruction. Regardless of the original state of the controller, the controller enters the Test-Logic-Reset state when the TMS input is held high for at least 5 rising edges of TCK. The controller remains in this state while TMS is high. The device processor automatically enters this state at power-up. |
| Run-Test/Idle | This is a controller state between scan operations. Once in this state, the controller remains in the state as long as TMS is held low. The instruction register and all test data registers retain their previous state. When TMS is high and a rising edge is applied to TCK, the controller moves to the Select-DR state. |
| Select-DR-Scan | This is a temporary controller state and the instruction does not change in this state. The test data register selected by the current instruction retains its previous state. If TMS is held low and a rising edge is applied to TCK when in this state, the controller moves into the Capture-DR state and a scan sequence for the selected test data register is initiated. If TMS is held high and a rising edge applied to TCK, the controller moves to the Select-IR-Scan state. |
| Capture-DR | In this state, the Boundary Scan Register captures input pin data if the current instruction is EXTEST or SAMPLE/PRELOAD. The instruction does not change in this state. The other test data registers, which do not have parallel input, are not changed. When the TAP controller is in this state and a rising edge is applied to TCK, the controller enters the Exit1-DR state if TMS is high or the Shift-DR state if TMS is low. |
| Shift-DR | In this controller state, the test data register connected between TDI and TDO as a result of the current instruction shifts data on stage toward its serial output on each rising edge of TCK. The instruction does not change in this state. When the TAP controller is in this state and a rising edge is applied to TCK, the controller enters the Exit1-DR state if TMS is high or remains in the Shift-DR state if TMS is low. |
| Exit1-DR | This is a temporary state. While in this state, if TMS is held high, a rising edge applied to TCK causes the controller to enter the Update-DR state, which terminates the scanning process. If TMS is held low and a rising edge is applied to TCK, the controller enters the Pause-DR state. The test data register selected by the current instruction retains its previous value and the instruction does not change during this state. |
| Pause-DR | The pause state allows the test controller to temporarily halt the shifting of data through the test data register in the serial path between TDI and TDO. For example, this state could be used to allow the tester to reload its pin memory from disk during application of a long test sequence. The test data register selected by the current instruction retains its previous value and the instruction does not change during this state. The controller remains in this state as long as TMS is low. When TMS goes high and a rising edge is applied to TCK, the controller moves to the Exit2-DR state. |
| Exit2-DR | This is a temporary state. While in this state, if TMS is held high, a rising edge applied to TCK causes the controller to enter the Update-DR state, which terminates the scanning process. If TMS is held low and a rising edge is applied to TCK, the controller enters the Shift-DR state. The test data register selected by the current instruction retains its previous value and the instruction does not change during this state. |
| Update-DR | The Boundary Scan Register is provided with a latched parallel output to prevent changes while data is shifted in response to the EXTEST and SAMPLE/PRELOAD instructions. When the TAP controller is in this state and the Boundary Scan Register is selected, data is latched into the parallel output of this register from the shift-register path on the falling edge of TCK. The data held at the latched parallel output changes only in this state. All shift-register stages in the test data register selected by the current instruction retain their previous value and the instruction does not change during this state. |
| Select-IR-Scan | This is a temporary controller state. The test data register selected by the current instruction retains its previous state. If TMS is held low and a rising edge is applied to TCK when in this state, the controller moves into the Capture-IR state, and a scan sequence for the instruction register is initiated. If TMS is held high and a rising edge is applied to TCK, the controller moves to the Test-Logic-Reset state. The instruction does not change during this state. |
| Capture-IR | In this controller state, the shift register contained in the instruction register loads a fixed value of '100' on the rising edge of TCK. This supports fault-isolation of the board-level serial test data path. Data registers selected by the current instruction retain their value and the instruction does not change during this state. When the controller is in this state and a rising edge is applied to TCK, the controller enters the Exit1-IR state if TMS is held high, or the Shift-IR state if TMS is held low. |
| Shift-IR | In this state, the shift register contained in the instruction register is connected between TDI and TDO and shifts data one stage towards its serial output on each rising edge of TCK. The test data register selected by the current instruction retains its previous value and the instruction does not change during this state. When the controller is in this state and a rising edge is applied to TCK, the controller enters the Exit1-IR state if TMS is held high, or remains in the Shift-IR state if TMS is held low. |

Table-16 TAP Controller State Description (Continued)

| State | Description |
|-----------|---|
| Exit1-IR | This is a temporary state. While in this state, if TMS is held high, a rising edge applied to TCK causes the controller to enter the Update-IR state, which terminates the scanning process. If TMS is held low and a rising edge is applied to TCK, the controller enters the Pause-IR state. The test data register selected by the current instruction retains its previous value and the instruction does not change during this state. |
| Pause-IR | The pause state allows the test controller to temporarily halt the shifting of data through the instruction register. The test data register selected by the current instruction retains its previous value and the instruction does not change during this state. The controller remains in this state as long as TMS is low. When TMS goes high and a rising edge is applied to TCK, the controller moves to the Exit2-IR state. |
| Exit2-IR | This is a temporary state. While in this state, if TMS is held high, a rising edge applied to TCK causes the controller to enter the Update-IR state, which terminates the scanning process. If TMS is held low and a rising edge is applied to TCK, the controller enters the Shift-IR state. The test data register selected by the current instruction retains its previous value and the instruction does not change during this state. |
| Update-IR | The instruction shifted into the instruction register is latched into the parallel output from the shift-register path on the falling edge of TCK. When the new instruction has been latched, it becomes the current instruction. The test data registers selected by the current instruction retain their previous value. |

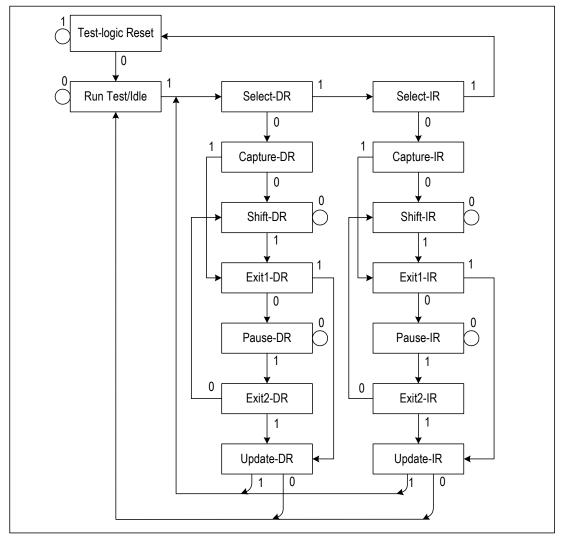


Figure-13 JTAG State Diagram

ABSOLUTE MAXIMUM RATING

| Symbol | Parameter | Min | Max | Unit |
|----------------|---|---------|------------------------|--------|
| VDDA, VDDD | Core Power Supply | -0.5 | 4.0 | V |
| VDDIO0, VDDIO1 | I/O Power Supply | -0.5 | 4.0 | V |
| VDDT0-7 | Transmit Power Supply | -0.5 | 7.0 | V |
| | Input Voltage, any digital pin | GND-0.5 | 5.5 | V |
| Vin | Input Voltage ⁽¹⁾ , RTIPn pins and RRINGn pins | GND-0.5 | VDDA+ 0.5 VDDD+ 0.5 | V V |
| | ESD Voltage, any pin ⁽²⁾ | 2000 | | V |
| | Transient Latch-up Current, any pin | | 100 | mA |
| lin | Input Current, any digital pin ⁽³⁾ | -10 | 10 | mA |
| | DC Input Current, any analog pin ⁽³⁾ | | ±100 | mA |
| Pd | Maximum Power Dissipation in package | | 1.6 | W |
| Ts | Storage Temperature | -65 | +150 | °C |

CAUTION: Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Тур | Max | Unit |
|---------------------|--|------|-----|------|------|
| VDDA, VDDD | Core Power Supply | 3.13 | 3.3 | 3.47 | V |
| VDDIO | I/O Power Supply | 3.13 | 3.3 | 3.47 | V |
| VDDT ⁽¹⁾ | Transmitter Supply | | | | |
| | 3.3 V | 3.13 | 3.3 | 3.47 | V |
| | 5 V | 4.75 | 5.0 | 5.25 | V |
| T _A | Ambient Operating Temperature | -40 | 25 | 85 | °C |
| R_L | Output load at TTIPn pins and TRINGn pins | 25 | | | Ω |
| I _{VDD} | Average Core Power Supply Current ⁽²⁾ | | 55 | 65 | mA |
| I _{VDDIO} | I/O Power Supply Current ⁽³⁾ | | 15 | 25 | mA |
| I _{VDDT} | Average transmitter power supply current, T1 mode ^{(2),(4),(5)} | | | | |
| | 50% ones density data: | | | 230 | mA |
| | 100% ones density data: | | | 440 | mA |

^{1.} T1 is only 5V VDDT.

^{1.} Referenced to ground

^{2.} Human body model

^{3.} Constant input current

^{2.} Maximum power and current consumption over the full operating temperature and power supply voltage range. Includes all channels.

^{3.} Digital output is driving 50 pF load, digital input is within 10% of the supply rails.

^{4.} T1 maximum values measured with maximum cable length (LEN = 111). Typical values measured with typical cable length (LEN = 101).

⁵. Power consumption includes power absorbed by line load and external transmitter components.

POWER CONSUMPTION

| Symbol | Parameter | LEN | Min | Тур | Max ⁽¹⁾⁽²⁾ | Unit |
|--------|--------------------------------------|-----|-----|------|-----------------------|------|
| | E1, 3.3 V, 75 Ω Load | | | | | |
| | 50% ones density data: | 000 | - | 662 | - | mW |
| | 100% ones density data: | 000 | - | 1100 | 1177 | mW |
| | E1, 3.3 V, 120 Ω Load | | | | | |
| | 50% ones density data: | 000 | - | 576 | - | mW |
| | 100% ones density data: | 000 | - | 930 | 992 | mW |
| | E1, 5.0 V, 75 Ω Load | | | | | |
| | 50% ones density data: | 000 | - | 910 | - | mW |
| | 100% ones density data: | 000 | - | 1585 | 1690 | mW |
| | E1, 5.0 V, 120 Ω Load | | | | | |
| | 50% ones density data: | 000 | - | 785 | - | mW |
| | 100% ones density data: | 000 | - | 1315 | 1410 | mW |
| | T1, 5.0 V, 100 Ω Load ⁽³⁾ | | | | | |
| | 50% ones density data: | 101 | - | 1185 | - | mW |
| | 100% ones density data: | 111 | - | 2395 | 2670 | mW |

^{1.} Maximum power and current consumption over the full operating temperature and power supply voltage range. Includes all channels.

DC CHARACTERISTICS

| Symbol | Parameter | Min | Тур | Max | Unit |
|-----------------|--|--------------------------|---------------------|-------------------------|------|
| V _{IL} | Input Low Level Voltage | | | | |
| | MODE2 and Dn pins | | | 1/3 VDDIO-0.2 | V |
| | All other digital inputs pins | | | 0.8 | V |
| V _{IM} | Input Mid Level Voltage | | | | |
| | MODE2 and Dn pins | $\frac{1}{3}$ VDDIO+0.2 | $\frac{1}{2}$ VDDIO | $\frac{2}{3}$ VDDIO-0.2 | V |
| V _{IH} | Input High Voltage | | | | |
| | MODE2 and Dn pins | $\frac{2}{3}$ VDDIO+ 0.2 | | | V |
| | All other digital inputs pins | 2.0 | | | V |
| V_{OL} | Output Low level Voltage ⁽¹⁾ (lout = 1.6 mA) | | | 0.4 | V |
| V _{OH} | Output High level Voltage ⁽¹⁾ (lout = 400 μA) | 2.4 | | VDDIO | V |
| V_{MA} | Analog Input Quiescent Voltage (RTIPn/RRINGn pin while floating) | 1.33 | 1.4 | 1.47 | V |
| I _H | Input High Level Current (MODE2 and Dn pins) | | | 50 | μΑ |
| ΙL | Input Low Level Current (MODE2 and Dn pins) | | | 50 | μΑ |
| l _l | Input Leakage Current | | | | |
| | TMS, TDI and \overline{TRST} pins | | | 50 | μΑ |
| | All other digital input pins | -10 | | 10 | μΑ |
| I_{ZL} | High Impedance Leakage Current | -10 | <u> </u> | 10 | μΑ |
| Z _{OH} | Output High Impedance on TTIPn and TRINGn pins | 150 | | | kΩ |

^{1.} Output drivers will output CMOS logic levels into CMOS loads.

 $^{^{2\}cdot}$ Power consumption includes power absorbed by line load and external transmitter components.

^{3.} T1 maximum values measured with maximum cable length (LEN = 111). Typical values measured with typical cable length (LEN = 101).

TRANSMITTER CHARACTERISTICS

| Symbol | | Parameter | Min | Тур | Max | Unit |
|------------------|---|--|-------------------------|--------------------|----------------------|----------------|
| V _{o-p} | Output Pulse Amplitudes ⁽¹⁾ E1, 75 Ω load E1, 120 Ω load T1, 100 Ω load | | 2.14 2.7 2.4 | 2.37 3.0 3.0 | 2.6 3.3 3.6 | V V V |
| V _{O-S} | Zero (space) Level E1, 75 Ω load E1, 120 Ω load T1, 100 Ω load | | -0.237 -0.3 -0.15 | | 0.237 0.3 0.15 | V V V |
| | Transmit Amplitude Variation with sup | . , | -1 | | +1 | % |
| | Difference between pulse sequences | - | | | 200 | mV |
| T _{PW} | Output Pulse Width at 50% of nomina E1: T1: | | 232 338 | 244 350 | 256 362 | ns ns |
| | Ratio of the amplitudes of Positive and | d Negative Pulses at the center of the pulse interval | 0.95 | | 1.05 | |
| RTX | Transmit Return Loss ⁽²⁾ | | | | | |
| | Ε1, 75 Ω | 51 kHz – 102 kHz 102 kHz – 2.048 MHz 2.048 MHz – 3.072 MHz | 15 15 15 | | | dB dB dB |
| | E1, 120 Ω | 51 kHz – 102 kHz 102 kHz – 2.048 MHz 2.048 MHz – 3.072 MHz | 15 15 15 | | | dB dB dB |
| | T1 (VDDT = 5 V) | 51 kHz – 102 kHz 102 kHz – 2.048 MHz 2.048 MHz – 3.072 MHz | 15 15 15 | | | dB dB dB |
| Td | Transmit Path Delay | | | 3 | | U.I. |
| I _{SC} | Line Short Circuit Current (3) | | | 180 | | mAp |

^{1.} E1: measured at the line output ports; T1: measured at the DSX

^{2.} Test at IDT82V2048L evaluation board

^{3.} Measured on device, between TTIPn and TRINGn

RECEIVER CHARACTERISTICS

| Symbol | Parameter | Min | Тур | Max | Unit |
|--------------------|---|----------------------|-------------------|------------------|----------------|
| ATT | Permissible Cable Attenuation (E1: @ 1024 kHz, T1: @ 772 kHz) | | | 15 | dB |
| IA | Input Amplitude | 0.1 | | 0.9 | Vp |
| SIR | Signal to Interference Ratio Margin ⁽¹⁾ | -15 | | | dB |
| SRE | Data Decision Threshold (refer to peak input voltage) | | 50 | | % |
| | Data Slicer Threshold | | 150 | | mV |
| | Analog Loss Of Signal ⁽²⁾ Declare/Clear: | 120/150 | 200/250 | 280/350 | mVp |
| | Allowable consecutive zeros before LOS E1, G.775: E1, ETSI 300 233: T1, T1.231-1993 | | 32 2048 175 | | |
| | LOS Reset Clock Recovery Mode | 12.5 | | | % ones |
| JRX _{p-p} | Peak to Peak Intrinsic Receive Jitter (JA disabled) E1 (wide band): T1 (wide band): | | | 0.0625 0.0625 | U.I. U.I. |
| ZDM | Receiver Differential Input Impedance | | 120 | | kΩ |
| ZCM | Receiver Common Mode Input Impedance to GND | 10 | | | kΩ |
| RRX | Receive Return Loss 51 kHz – 102 kHz 102 kHz – 2.048 MHz 2.048 MHz – 3.072 MHz | 20 20 20 20 | | | dB dB dB |
| | Receive Path Delay | | 3 | | U.I. |

^{1.} E1: per G.703, O.151 @ 6 dB cable attenuation. T1: @ 655 ft. of 22 ABAM cable

^{2.} Measured on device, between RTIPn and RRINGn, all ones signal

TRANSCEIVER TIMING CHARACTERISTICS

| Symbol | Parameter | Min | Тур | Max | Unit |
|---------------|---|------|-------|-----|------|
| | MCLK Frequency | | | | |
| | E1: | | 2.048 | | MHz |
| | T1: | | 1.544 | | MHz |
| | MCLK Tolerance | -100 | | 100 | ppm |
| | MCLK Duty Cycle | 40 | | 60 | % |
| Transmit Path | · | | | | |
| | TCLK Frequency | | | | |
| | E1: | | 2.048 | | MHz |
| | T1: | | 1.544 | | MHz |
| | TCLK Tolerance | -50 | | +50 | ppm |
| | TCLK Duty Cycle | 10 | | 90 | % |
| t1 | Transmit Data Setup Time | 40 | | | ns |
| t2 | Transmit Data Hold Time | 40 | | | ns |
| | Delay time of OE low to driver High Impedance | | | 1 | μs |
| | Delay time of TCLK low to driver High Impedance | 40 | 44 | 48 | μs |
| Receive Path | 1 | | | | |
| t4 | RDN/RDP Pulse Width ⁽¹⁾ | | | | |
| | E1: | 200 | 244 | | ns |
| | T1: | 300 | 324 | | ns |
| t5 | RX Data Prop. Delay ⁽²⁾ | | | 40 | ns |
| t6 | Receive Rise Time ⁽²⁾ | | | 14 | ns |
| t7 | Receive Fall Time ⁽²⁾ | | | 12 | ns |

^{1. 0} dB cable loss

^{2.} 15 pF load

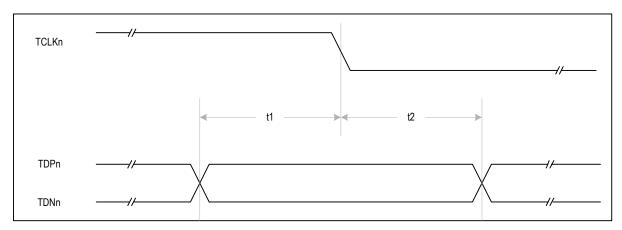


Figure-14 Transmit System Interface Timing

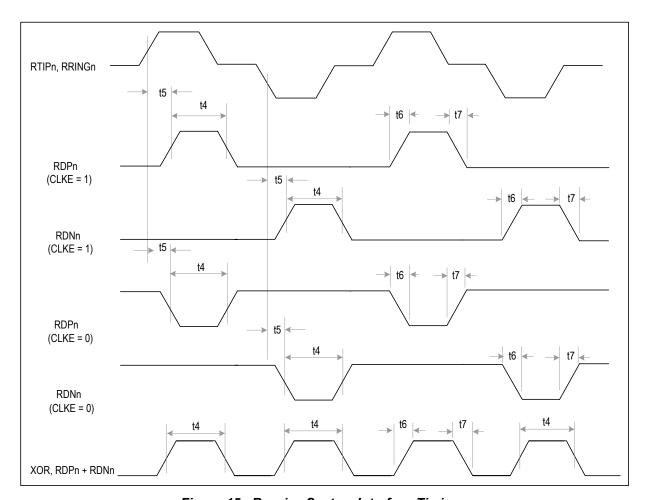


Figure-15 Receive System Interface Timing

JTAG TIMING CHARACTERISTICS

| Symbol | Parameter | Min | Тур | Max | Unit | Comments |
|--------|--|-----|-----|-----|------|----------|
| t1 | TCK Period | 200 | | | ns | |
| t2 | TMS to TCK setup Time TDI to TCK Setup Time | 50 | | | ns | |
| t3 | TCK to TMS Hold Time TCK to TDI Hold Time | 50 | | | ns | |
| t4 | TCK to TDO Delay Time | | | 100 | ns | |

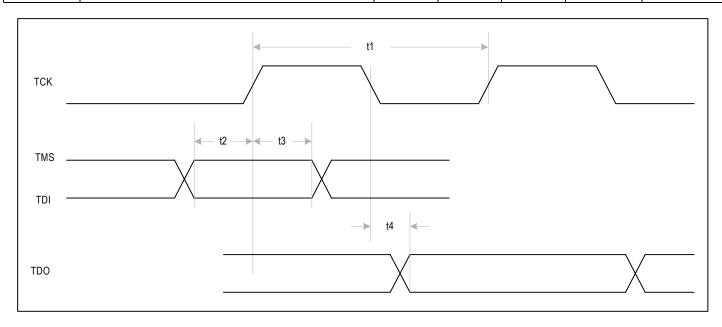


Figure-16 JTAG Interface Timing

PARALLEL HOST INTERFACE TIMING CHARACTERISTICS

INTEL MODE READ TIMING CHARACTERISTICS

| Symbol | Parameter | Min | Тур | Max | Unit | Comments |
|--------|---|-----|-----|-----|------|----------|
| t1 | Active RD Pulse Width | 90 | | | ns | (1) |
| t2 | Active CS to Active RD Setup Time | 0 | | | ns | |
| t3 | Inactive RD to Inactive CS Hold Time | 0 | | | ns | |
| t4 | Valid Address to Inactive ALE Setup Time (in Multiplexed Mode) | 5 | | | ns | |
| t5 | Invalid RD to Address Hold Time (in Non-Multiplexed Mode) | 0 | | | ns | |
| t6 | Active RD to Data Output Enable Time | 7.5 | | 15 | ns | |
| t7 | Inactive RD to Data High Impedance Delay Time | 7.5 | | 15 | ns | |
| t8 | Active CS to RDY delay time | 6 | | 12 | ns | |
| t9 | Inactive CS to RDY High Impedance Delay Time | 6 | | 12 | ns | |
| t10 | Inactive RD to Inactive INT Delay Time | | | 20 | ns | |
| t11 | Address Latch Enable Pulse Width (in Multiplexed Mode) | 10 | | | ns | |
| t12 | Address Latch Enable to RD Setup Time (in Multiplexed Mode) | 0 | | | ns | |
| t13 | Address Setup time to Valid Data Time (in Non-Multiplexed Mode) | 18 | | 32 | ns | |
| t14 | Inactive RD to Active RDY Delay Time | 10 | | 15 | ns | |
| t15 | Active RD to Active RDY Delay Time | 30 | | 85 | ns | |
| t16 | Inactive ALE to Address Hold Time (in Multiplexed Mode) | 5 | | | ns | |

¹ The t1 is determined by the start time of the valid data when the RDY signal is not used.

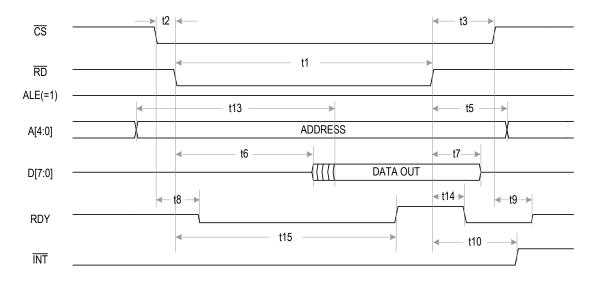


Figure-17 Non-Multiplexed Intel Mode Read Timing

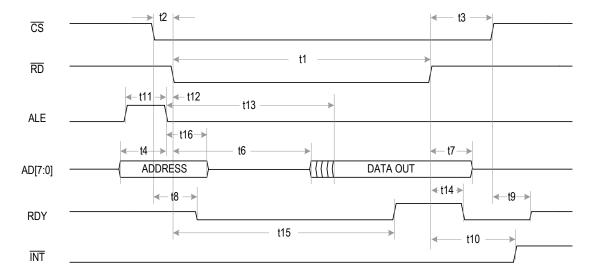


Figure-18 Multiplexed Intel Mode Read Timing

INTEL MODE WRITE TIMING CHARACTERISTICS

| Symbol | Parameter | Min | Тур | Max | Unit | Comments |
|--------|--|-----|-----|-----|------|----------|
| t1 | Active WR Pulse Width | 90 | | | ns | (1) |
| t2 | Active CS to Active WR Setup Time | 0 | | | ns | |
| t3 | Inactive WR to Inactive CS Hold Time | 0 | | | ns | |
| t4 | Valid Address to Latch Enable Setup Time (in Multiplexed Mode) | 5 | | | ns | |
| t5 | Invalid WR to Address Hold Time (in Non-Multiplexed Mode) | 2 | | | ns | |
| t6 | Valid Data to Inactive WR Setup Time | 5 | | | ns | |
| t7 | Inactive WR to Data Hold Time | 10 | | | ns | |
| t8 | Active CS to Inactive RDY Delay Time | 6 | | 12 | ns | |
| t9 | Active WR to Active RDY Delay Time | 30 | | 85 | ns | |
| t10 | Inactive WR to Inactive RDY Delay Time | 10 | | 15 | ns | |
| t11 | Invalid CS to RDY High Impedance Delay Time | 6 | | 12 | ns | |
| t12 | Address Latch Enable Pulse Width (in Multiplexed Mode) | 10 | | | ns | |
| t13 | Inactive ALE to WR Setup Time (in Multiplexed Mode) | 0 | | | ns | |
| t14 | Inactive ALE to Address hold time (in Multiplexed Mode) | 5 | | | ns | |
| t15 | Address setup time to Inactive WR time (in Non-Multiplexed Mode) | 5 | | | ns | |

^{1.} The t1 can be 15 ns when RDY signal is not used.

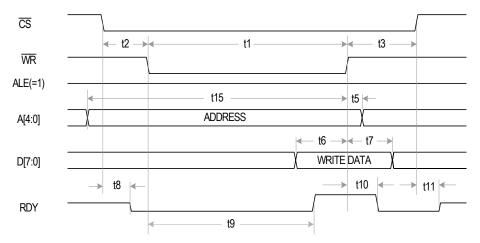


Figure-19 Non-Multiplexed Intel Mode Write Timing

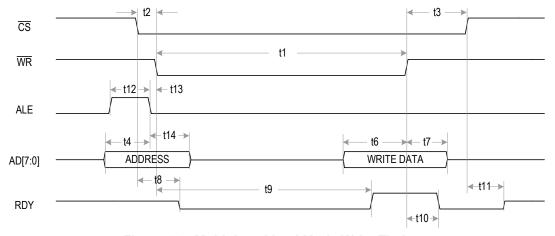


Figure-20 Multiplexed Intel Mode Write Timing

MOTOROLA MODE READ TIMING CHARACTERISTICS

| Symbol | Parameter | Min | Тур | Max | Unit | Comments |
|--------|--|-----|-----|-----|------|----------|
| t1 | Active DS Pulse Width | 90 | | | ns | (1) |
| t2 | Active CS to Active DS Setup Time | 0 | | | ns | |
| t3 | Inactive $\overline{\text{DS}}$ to Inactive $\overline{\text{CS}}$ Hold Time | 0 | | | ns | |
| t4 | Valid R/W to Active DS Setup Time | 0 | | | ns | |
| t5 | Inactive $\overline{\text{DS}}$ to R/W Hold Time | 0.5 | | | ns | |
| t6 | Valid Address to Active DS Setup Time (in Non-Multiplexed Mode) | 5 | | | ns | |
| t7 | Active DS to Address Hold Time (in Non-Multiplexed Mode) | 10 | | | ns | |
| t8 | Active DS to Data Valid Delay Time (in Non-Multiplexed Mode) | 20 | | 35 | ns | |
| t9 | Active DS to Data Output Enable Time | 7.5 | | 15 | ns | |
| t10 | Inactive DS to Data High Impedance Delay Time | 7.5 | | 15 | ns | |
| t11 | Active DS to Active ACK Delay Time | 30 | | 85 | ns | |
| t12 | Inactive DS to Inactive ACK Delay Time | 10 | | 15 | ns | |
| t13 | Inactive DS to Invalid INT Delay Time | | | 20 | ns | |
| t14 | Active AS to Active DS Setup Time (in Multiplexed Mode) | 5 | | | ns | |

¹ The t1 is determined by the start time of the valid data when the ACK signal is not used.

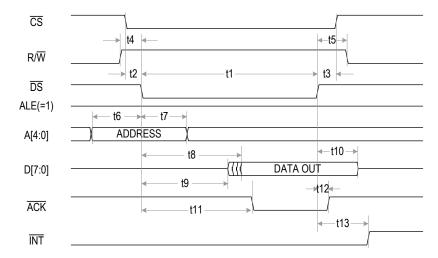


Figure-21 Non-Multiplexed Motorola Mode Read Timing

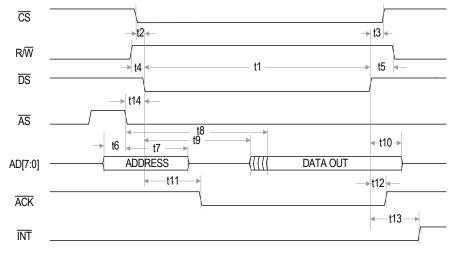


Figure-22 Multiplexed Motorola Mode Read Timing

MOTOROLA MODE WRITE TIMING CHARACTERISTICS

| Symbol | Parameter | Min | Тур | Max | Unit | Comments |
|--------|--|-----|-----|-----|------|----------|
| t1 | Active DS Pulse Width | 90 | | | ns | (1) |
| t2 | Active CS to Active DS Setup Time | 0 | | | ns | |
| t3 | Inactive DS to Inactive CS Hold Time | 0 | | | ns | |
| t4 | Valid R/W to Active DS Setup Time | 10 | | | ns | |
| t5 | Inactive DS to R/W Hold Time | 0 | | | ns | |
| t6 | Valid Address to Active DS Setup Time (in Non-Multiplexed Mode) | 10 | | | ns | |
| t7 | Valid DS to Address Hold Time (in Non-Multiplexed Mode) | 10 | | | ns | |
| t8 | Valid Data to Inactive DS Setup Time | 5 | | | ns | |
| t9 | Inactive DS to Data Hold Time | 10 | | | ns | |
| t10 | Active DS to Active ACK Delay Time | 30 | | 85 | ns | |
| t11 | Inactive DS to Inactive ACK Delay Time | 10 | | 15 | ns | |
| t12 | Active AS to Active DS (in Multiplexed Mode) | 0 | | | ns | |
| t13 | Inactive $\overline{\text{DS}}$ to Inactive $\overline{\text{AS}}$ Hold Time (in Multiplexed Mode) | 15 | | | ns | |

^{1.} The t1 can be 15ns when the ACK signal is not used.

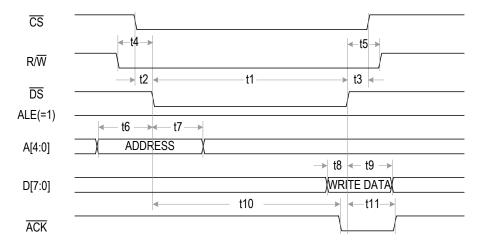


Figure-23 Non-Multiplexed Motorola Mode Write Timing

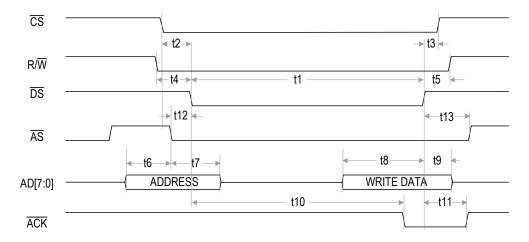


Figure-24 Multiplexed Motorola Mode Writing Timing

SERIAL HOST INTERFACE TIMING CHARACTERISTICS

| Symbol | Parameter | Min | Тур | Max | Unit | Comments |
|--------|---|-----|-----|-----|------|--------------|
| t1 | SCLK High Time | 25 | | | ns | |
| t2 | SCLK Low Time | 25 | | | ns | |
| t3 | Active CS to SCLK Setup Time | 10 | | | ns | |
| t4 | Last SCLK Hold Time to Inactive CS Time | 50 | | | ns | |
| t5 | CS Idle Time | 50 | | | ns | |
| t6 | SDI to SCLK Setup Time | 5 | | | ns | |
| t7 | SCLK to SDI Hold Time | 5 | | | ns | |
| t8 | Rise/Fall Time (any pin) | | | 100 | ns | |
| t9 | SCLK Rise and Fall Time | | | 50 | ns | |
| t10 | SCLK to SDO Valid Delay Time | | 25 | 35 | ns | Load = 50 pF |
| t11 | SCLK Falling Edge to SDO High Impedance Hold Time (CLKE = 0) or $\overline{\text{CS}}$ Rising Edge to SDO High Impedance Hold Time (CLKE = 1) | | 100 | | ns | |

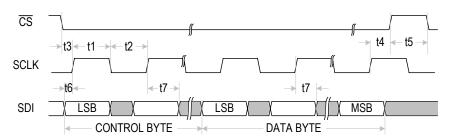


Figure-25 Serial Interface Write Timing

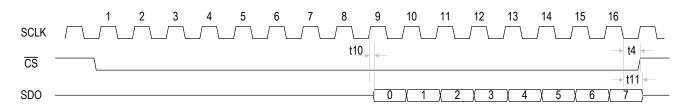


Figure-26 Serial Interface Read Timing with CLKE = 0

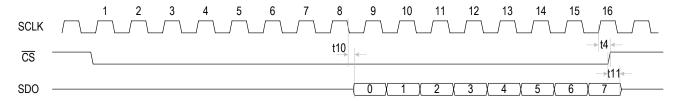
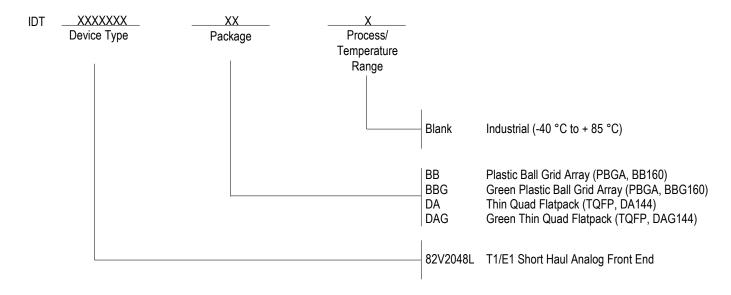


Figure-27 Serial Interface Read Timing with CLKE = 1

ORDERING INFORMATION



DATASHEET DOCUMENT HISTORY

07/29/2005 pgs. 1, 4, 5, 7 to 10, 13, 15 to 17, 19, 20, 22, 23, 25, 25, 28, 32, 35, 37 to 40, 43 to 47



CORPORATE HEADQUARTERS

6024 Silver Creek Valley Road San Jose, CA 95138 www.idt.com for SALES:

1-800-345-7015 or 408-284-8200 fax: 408-284-2775

for Tech Support: 408-360-1552 email:telecomhelp@idt.com